



DDC112



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Dual Current Input 20-Bit ANALOG-TO-DIGITAL CONVERTER

FEATURES

- MONOLITHIC CHARGE MEASUREMENT ADC
- DIGITAL FILTER NOISE REDUCTION:
3.2ppm, rms
- INTEGRAL LINEARITY:
 $\pm 0.005\%$ Reading $\pm 0.5\text{ppm}$ FSR
- HIGH PRECISION, TRUE INTEGRATING
FUNCTION
- PROGRAMMABLE FULL SCALE
- SINGLE SUPPLY
- CASCADABLE OUTPUT

APPLICATIONS

- DIRECT PHOTSENSOR DIGITIZATION
- CT SCANNER DAS
- INFRARED PYROMETER
- PRECISION PROCESS CONTROL
- LIQUID/GAS CHROMATOGRAPHY
- BLOOD ANALYSIS

DESCRIPTION

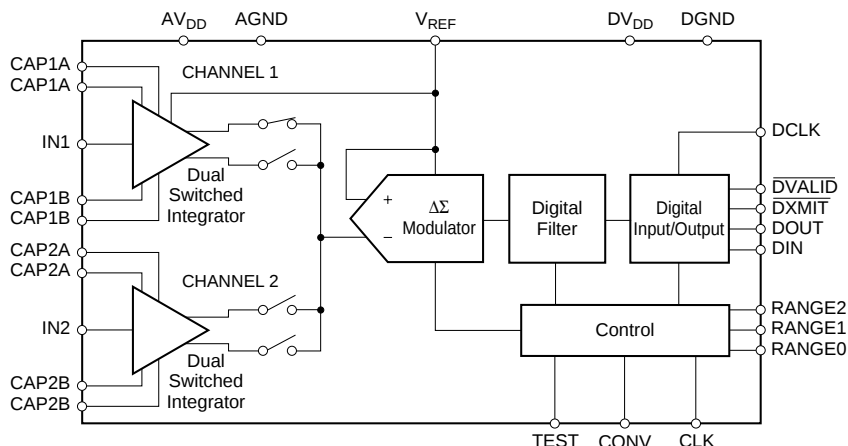
The DDC112 is a dual input, wide dynamic range, charge-digitizing analog-to-digital converter (ADC) with 20-bit resolution. Low level current output devices, such as photosensors, can be directly connected to its inputs. Charge integration is continuous as each input uses two integrators; while one is being digitized, the other is integrating.

For each of its two inputs, the DDC112 combines current-to-voltage conversion, continuous integration, programmable full-scale range, A/D conversion, and digital filtering to achieve a precision, wide dynamic range digital result. In addition to the internal programmable full-scale ranges, external integrating capacitors allow an additional user-settable full-scale range of up to 1000pC.

To provide single-supply operation, the internal ADC utilizes a differential input, with the positive input tied to V_{REF} . When the integration capacitor is reset at the beginning of each integration cycle, the capacitor charges to V_{REF} . This charge is removed in proportion to the input current. At the end of the integration cycle, the remaining voltage is compared to V_{REF} .

The high-speed serial shift register which holds the result of the last conversion can be configured to allow multiple DDC112 units to be cascaded, minimizing interconnections. The DDC112 is available in a SO-28 package and is offered in two performance grades.

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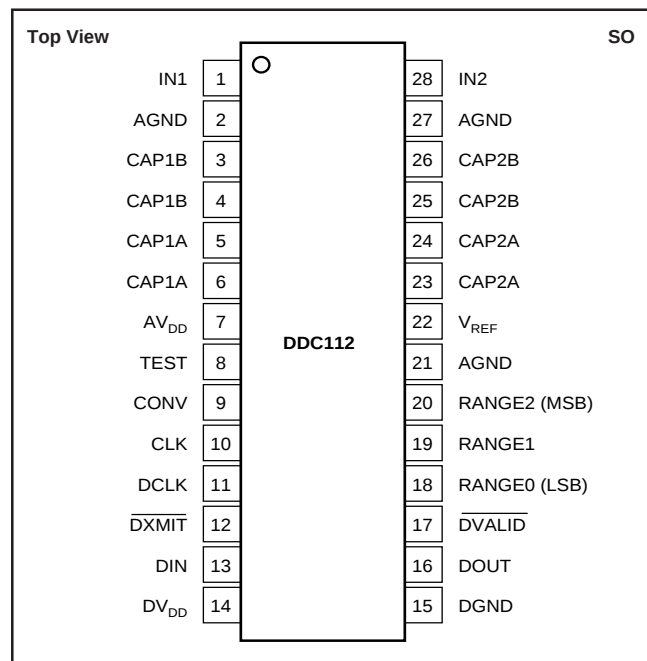
SPECIFICATIONS

At $T_A = +25^\circ\text{C}$, $AV_{DD} = DV_{DD} = +5\text{V}$, DDC112U: $T_{INT} = 500\mu\text{s}$, $\text{CLK} = 10\text{MHz}$, DDC112UK: $T_{INT} = 333.3\mu\text{s}$, $\text{CLK} = 15\text{MHz}$, $V_{REF} = +4.096\text{V}$, continuous mode operation, and internal integration capacitors, unless otherwise noted.

PARAMETER	CONDITIONS	DDC112U			DDC112UK			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
ANALOG INPUTS								
External, Positive Full-Scale Range 0	$C_{EXT} = 250\text{pF}$			1000			*	pC
Internal, Positive Full-Scale Range 1		47.5	50	52.5	*	*	*	pC
Range 2		95	100	105	*	*	*	pC
Range 3		142.5	150	157.5	*	*	*	pC
Range 4		190	200	210	*	*	*	pC
Range 5		237.5	250	262.5	*	*	*	pC
Range 6		285	300	315	*	*	*	pC
Range 7		332.5	350	367.5	*	*	*	pC
Negative Full-Scale Input		-0.4% of Positive FS				*		pC
DYNAMIC CHARACTERISTICS								
Conversion Rate	Continuous Mode Non-continuous Mode			2			3	kHz
Integration Time, T_{INT}		500		1,000,000	333.3		*	μs
Integration Time, T_{INT}		50			*			μs
System Clock Input (CLK)		1	10	12	*	*	15	MHz
Data Clock (DCLK)				12			15	MHz
ACCURACY								
Noise, Low Level Current Input ⁽¹⁾	$C_{SENSOR}^{(2)} = 0\text{pF}$, Range 5 (250pC) $C_{SENSOR} = 25\text{pF}$, Range 5 (250pC) $C_{SENSOR} = 50\text{pF}$, Range 5 (250pC)		3.2			*		ppm of FSR ⁽³⁾ , rms
			3.8			*		ppm of FSR, rms
			4.2	6.0		*	7	ppm of FSR, rms
			$\pm 0.005\%$ Reading $\pm 0.5\text{ppm}$ FSR, max				*	
Differential Linearity Error			$\pm 0.005\%$ Reading $\pm 0.5\text{ppm}$ FSR, typ			*		
Integral Linearity Error ⁽⁴⁾			$\pm 0.025\%$ Reading $\pm 1.0\text{ppm}$ FSR, max				*	
No Missing Codes			20			*		Bits
Input Bias Current	$T_A = +25^\circ\text{C}$ Range 5 (250pC) All Ranges $V_{REF} = 4.096 \pm 0.1\text{V}$ Range 5, (250pC)		0.1	10		*	*	pA
Range Error				5		*	*	% of FSR
Range Error Match ⁽⁵⁾			0.1	0.5		*	*	% of FSR
Range Sensitivity to V_{REF}			1:1			*		
Offset Error			± 200			*	± 600	ppm of FSR
Offset Error Match ⁽⁵⁾			± 100			*		ppm of FSR
DC Bias Voltage ⁽⁶⁾ (Input V_{OS})			± 0.05	± 2		*	*	mV
Power Supply Rejection Ratio			± 25	± 200		*	*	ppm of FSR/V
Internal Test Signal			13			*		pC
Internal Test Accuracy			± 10			*		%
PERFORMANCE OVER TEMPERATURE								
Offset Drift	Applied to Sensor Input $+25^\circ\text{C}$ to $+45^\circ\text{C}$ $T_A = +75^\circ\text{C}$ Range 5 (250pC) Range 5 (250pC)		± 0.5				$\pm 3^{(10)}$	ppm of FSR/ $^\circ\text{C}$
Offset Drift Stability			± 0.2			*	$\pm 0.7^{(10)}$	ppm of FSR/minute
DC Bias Voltage Drift			3			± 1		$\mu\text{V}/^\circ\text{C}$
Input Bias Current Drift			0.01	$1^{(10)}$		*	*	pA/ $^\circ\text{C}$
Input Bias Current			2	$50^{(10)}$		*	*	pA
Range Drift ⁽⁷⁾			25		0	25	$50^{(10)}$	ppm/ $^\circ\text{C}$
Range Drift Match ⁽⁵⁾			± 0.05			*		ppm/ $^\circ\text{C}$
REFERENCE								
Voltage	$T_{INT} = 500\mu\text{s}$	4.000	4.096	4.200	*	*	*	V
Input Current ⁽⁸⁾			150			225	275	μA
DIGITAL INPUT/OUTPUT								
Logic Levels	$I_{OH} = -500\mu\text{A}$ $I_{OL} = 500\mu\text{A}$			$DV_{DD} + 0.3$				
V_{IH}		4.0			*		*	V
V_{IL}		-0.3		+0.8	*		*	V
V_{OH}		4.5			*		*	V
V_{OL}				0.4			*	V
Input Current, I_{IN}		-10		+10	*		*	μA
Data Format ⁽⁹⁾		Straight Binary				*		
POWER SUPPLY REQUIREMENTS								
Power Supply Voltage	AV_{DD} and DV_{DD} $AV_{DD} = +5\text{V}$ $DV_{DD} = +5\text{V}$	4.75		5.25	*		*	V
Supply Current								
Analog Current			14.8			15.2		mA
Digital Current			1.2			1.8		mA
Total Power Dissipation			80	100		85	130	mW
TEMPERATURE RANGE								
Specified Performance		-40		+85	0		+70	$^\circ\text{C}$
Storage		-60		+100	*		*	$^\circ\text{C}$

NOTES: (1) Input is less than 1% of full scale. (2) C_{SENSOR} is the capacitance seen at the DDC112 inputs from wiring, photodiode, etc. (3) FSR is Full-Scale Range. (4) A best-fit line is used in measuring linearity. (5) Matching between side A and side B, not input 1 to input 2. (6) Voltage produced by the DDC112 at its input which is applied to the sensor. (7) Range drift does not include external reference drift. (8) Input reference current decreases with increasing T_{INT} (see text). (9) Data format is Straight Binary with a small offset (see text). (10) Guaranteed but not tested.

PIN CONFIGURATION



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

AV _{DD} to DV _{DD}	–0.3V to +6V
AV _{DD} to AGND	–0.3V to +6V
DV _{DD} to DGND	–0.3V to +6V
AGND to DGND	±0.3V
V _{REF} Voltage to AGND	–0.3V to AV _{DD} +0.3V
Digital Input Voltage to DGND	–0.3V to DV _{DD} +0.3V
Digital Output Voltage to DGND	–0.3V to DV _{DD} +0.3V
Package Power Dissipation	(T _{JMAX} – T _A)/θ _{JA}
Maximum Junction Temperature (T _{JMAX})	+150°C
Thermal Resistance, θ _{JA}	150°C/W
Lead Temperature (soldering, 10s)	+300°C

NOTE: (1) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum conditions for extended periods may affect device reliability.



ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

PRODUCT	MAXIMUM INTEGRAL LINEARITY ERROR	SPECIFICATION TEMPERATURE RANGE	PACKAGE	PACKAGE DRAWING NUMBER	ORDERING NUMBER ⁽¹⁾	TRANSPORT MEDIA
DDC112U	±0.025% Reading ±1.0ppm% FSR	–40°C to +85°C	SO-28	217	DDC112U	Rails
"	"	"	"	"	DDC112U/1K	Tape and Reel
DDC112UK	±0.025% Reading ±1.0ppm% FSR	0°C to +70°C	SO-28	217	DDC112UK	Rails
"	"	"	"	"	DDC112UK/1K	Tape and Reel

NOTES: (1) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., /1K indicates 1000 devices per reel). Ordering 1000 pieces of "DDC112U/1K" will get a single 1000-piece Tape and Reel.

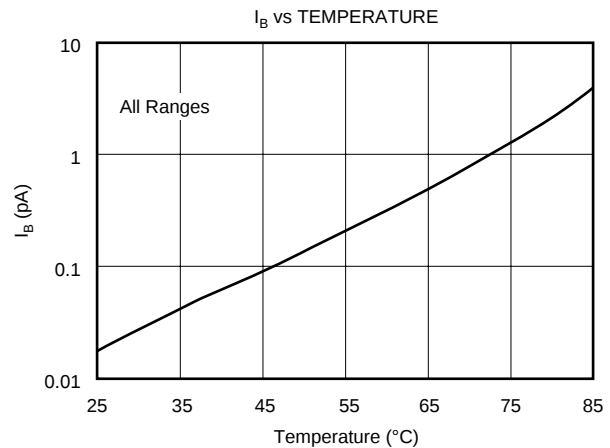
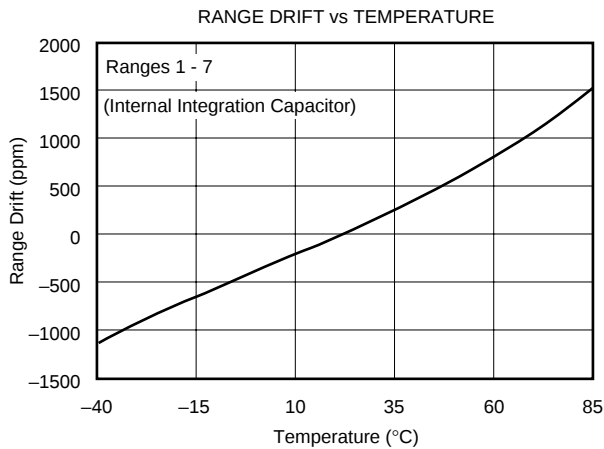
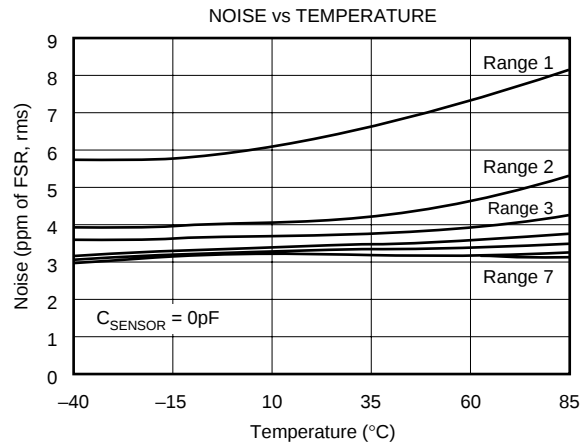
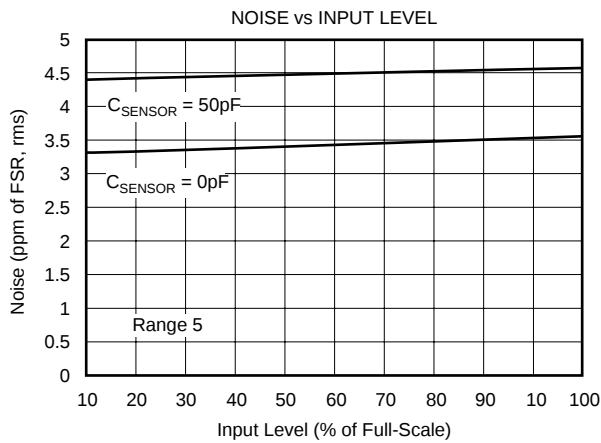
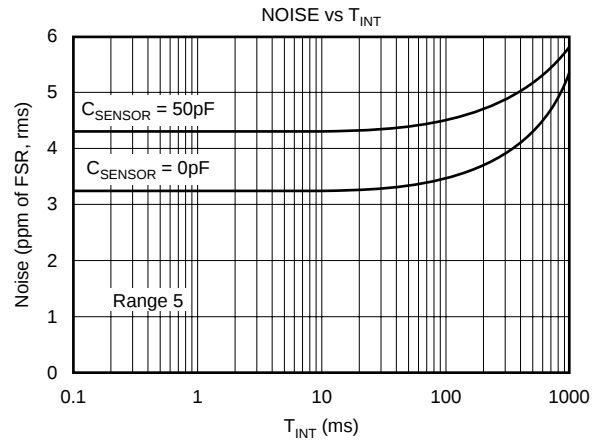
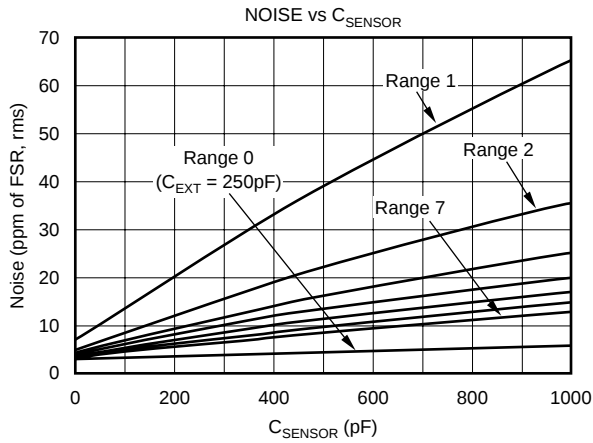
PIN DESCRIPTIONS

PIN	LABEL	DESCRIPTION
1	IN1	Input 1: analog input for Integrators 1A and 1B. The integrator that is active is set by the CONV input.
2	AGND	Analog Ground.
3	CAP1B	External Capacitor for Integrator 1B.
4	CAP1B	External Capacitor for Integrator 1B.
5	CAP1A	External Capacitor for Integrator 1A.
6	CAP1A	External Capacitor for Integrator 1A.
7	AV _{DD}	Analog Supply, +5V nominal.
8	TEST	Test Control Input. When HIGH, a test charge is applied to the A or B integrators on the next CONV transition.
9	CONV	Controls which side of the integrator is connected to input. In continuous mode; CONV HIGH → side A is integrating, CONV LOW → side B is integrating. CONV must be synchronized with CLK (see text).
10	CLK	System Clock Input, 10MHz nominal.
11	DCLK	Serial Data Clock Input. This input operates the serial I/O shift register.
12	DXMIT	Serial Data Transmit Enable Input. When LOW, this input enables the internal serial shift register.
13	DIN	Serial Digital Input. Used to cascade multiple DDC112s.
14	DV _{DD}	Digital Supply, +5V nominal.
15	DGND	Digital Ground.
16	DOUT	Serial Data Output, Hi-Z when DXMIT is HIGH.
17	DVALID	Data Valid Output. A LOW value indicates valid data is available in the serial I/O register.
18	RANGE0	Range Control Input 0 (least significant bit).
19	RANGE1	Range Control Input 1.
20	RANGE2	Range Control Input 2 (most significant bit).
21	AGND	Analog Ground.
22	V _{REF}	External Reference Input, +4.096V nominal.
23	CAP2A	External Capacitor for Integrator 2A.
24	CAP2A	External Capacitor for Integrator 2A.
25	CAP2B	External Capacitor for Integrator 2B.
26	CAP2B	External Capacitor for Integrator 2B.
27	AGND	Analog Ground.
28	IN2	Input 2: analog input for Integrators 2A and 2B. The integrator that is active is set by the CONV input.

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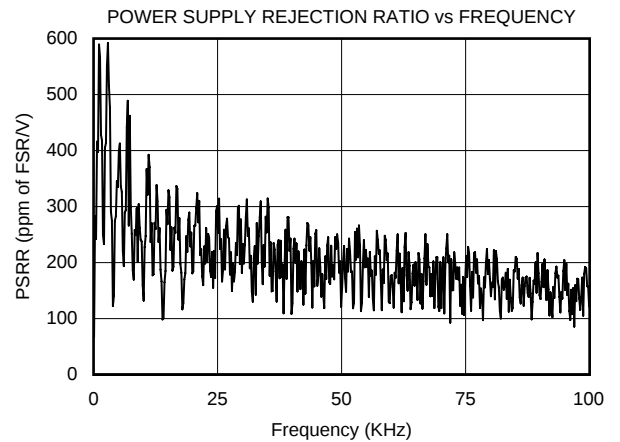
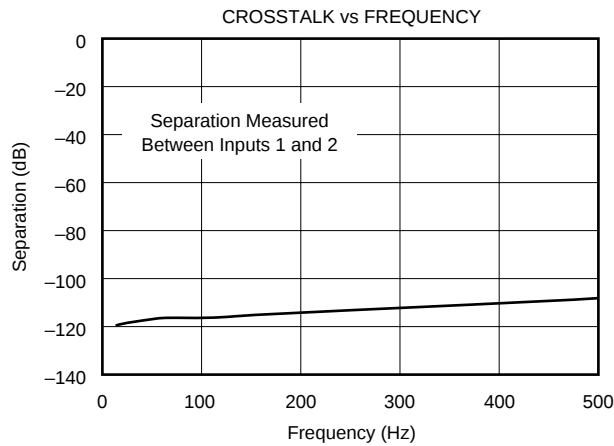
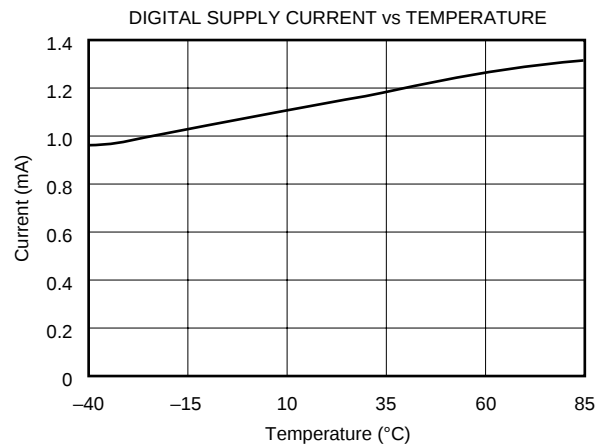
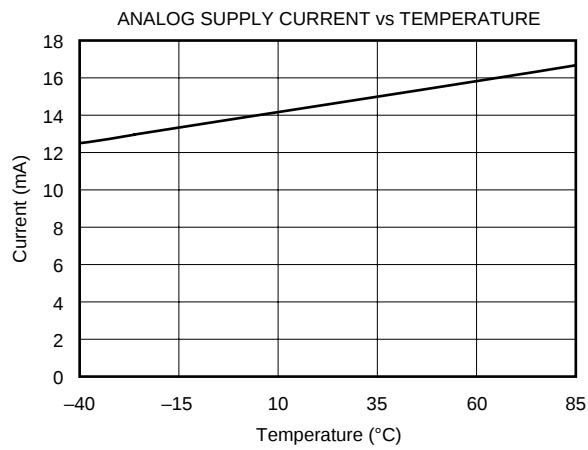
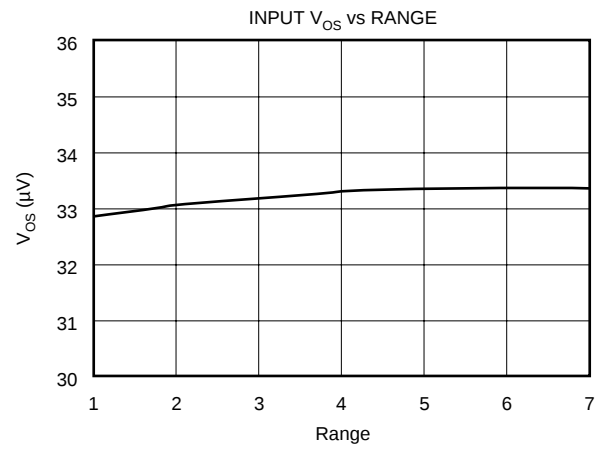
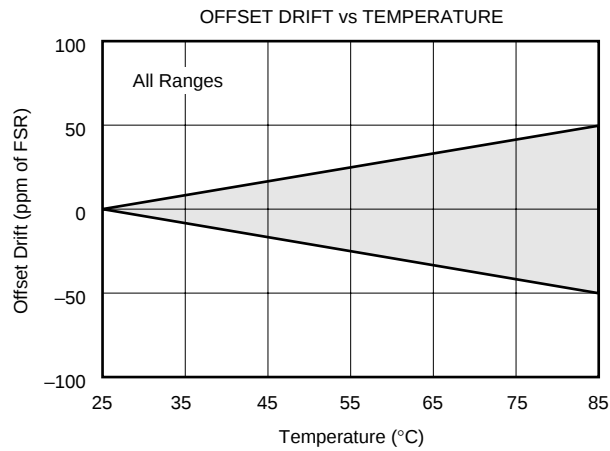
TYPICAL PERFORMANCE CURVES

At $T_A = +25^\circ\text{C}$, characterization done with Range 5 (250pC), $T_{\text{INT}} = 500\mu\text{s}$, $V_{\text{REF}} = +4.096$, $AV_{\text{DD}} = DV_{\text{DD}} = +5\text{V}$, and $\text{CLK} = 10\text{MHz}$, unless otherwise noted.



TYPICAL PERFORMANCE CURVES (Cont.)

At $T_A = +25^\circ\text{C}$, characterization done with Range 5 (250pC), $T_{INT} = 500\mu\text{s}$, $V_{REF} = +4.096$, $AV_{DD} = DV_{DD} = +5\text{V}$, and $\text{CLK} = 10\text{MHz}$, unless otherwise noted.



THEORY OF OPERATION

The basic operation of the DDC112 is illustrated in Figure 1. The device contains two identical input channels where each performs the function of current-to-voltage integration followed by a multiplexed analog-to-digital (A/D) conversion. Each input has two integrators so that the current-to-voltage integration can be continuous in time. The output of the four integrators are switched to one delta-sigma converter via a four input multiplexer. With the DDC112 in the continuous integration mode, the output of the integrators from one side of both of the inputs will be digitized while the other two integrators are in the integration mode as illustrated in the timing diagram in Figure 2. This integration and A/D conversion process is controlled by the system clock, CLK. With a 10MHz system clock, the integrator combined with the delta-sigma converter accomplishes a single 20-bit conversion in approximately 220 μ s. The results from side A and side B of each signal input are stored in a serial output shift

register. The $\overline{\text{DVALID}}$ output goes LOW when the shift register contains valid data.

The digital interface of the DDC112 provides the digital results via a synchronous serial interface consisting of a data clock (DCLK), a transmit enable pin ($\overline{\text{DXMIT}}$), a valid data pin ($\overline{\text{DVALID}}$), a serial data output pin (DOUT), and a serial data input pin (DIN). The DDC112 contains only one A/D converter, so the conversion process is interleaved between the two inputs, as shown in Figure 2. The integration and conversion process is fundamentally independent of the data retrieval process. Consequently, the CLK frequency and DCLK frequencies need not be the same. DIN is only used when multiple converters are cascaded and should be tied to DGND otherwise. Depending on T_{INT} , CLK, and DCLK, it is possible to daisy chain over 100 converters. This greatly simplifies the interconnection and routing of the digital outputs in those cases where a large number of converters are needed.

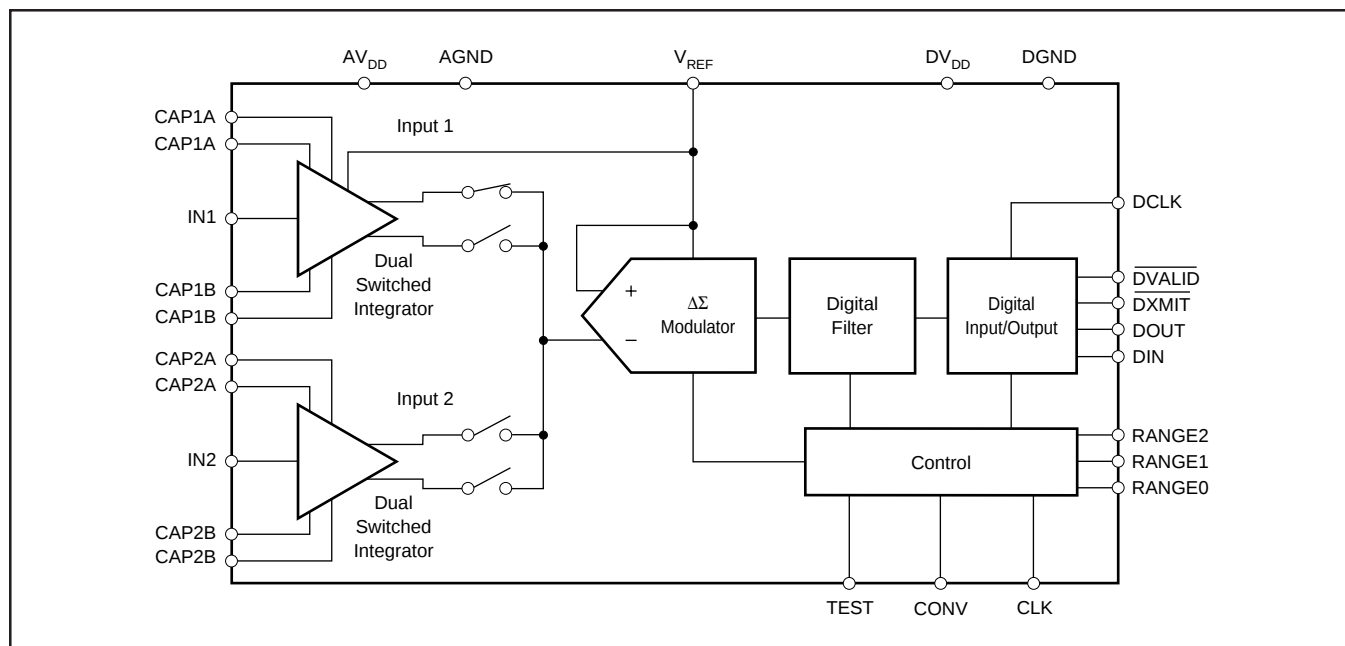


FIGURE 1. DDC112 Block Diagram.

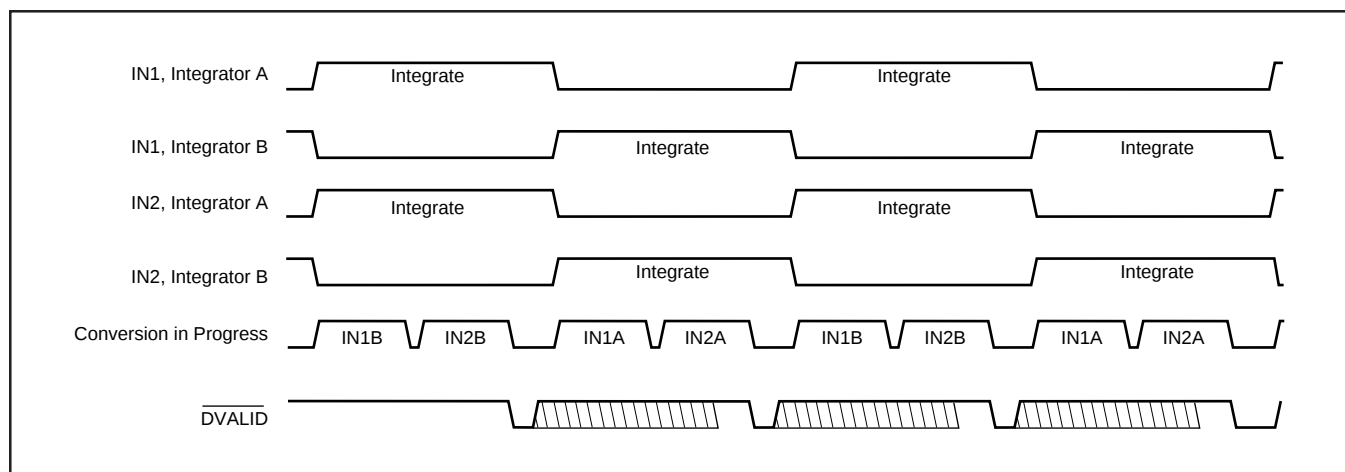


FIGURE 2. Basic Integration and Conversion Timing for the DDC112 (continuous mode).

DEVICE OPERATION

Basic Integration Cycle

The fundamental topology of the front end of the DDC112 is a classical analog integrator as shown in Figure 3. In this diagram, only Input 1 is shown. This representation of the input stage consists of an operational amplifier, a selectable feedback capacitor network (C_F), and several switches that implement the integration cycle. The timing relationships of all of the switches shown in Figure 3 are illustrated in Figure 4. Figure 4 is used to conceptualize the operation of the integrator input stage of the DDC112 and should not be used as an exact timing tool for design. Block diagrams of the reset, integrate, converter and wait states of the integrator section of the DDC112 are shown in Figure 5. This internal switching network is controlled externally with the convert command (CONV), range selection pins (RANGE0-RANGE2), and the system clock (CLK). For the best noise performance, CONV must be synchronized with the rising edge of CLK. It is recommended CONV toggle within ± 10 ns of the rising edge of CLK.

The non-inverting inputs of the integrators are internally referenced to ground. Consequently, the DDC112 analog ground should be as clean as possible. The range switches, along with the internal and external capacitors (C_F) are shown in parallel between the inverting input and output of the operational amplifier. Table I shows the value of the integration capacitor (C_F) for each range. At the beginning of a conversion, the switches $S_{A/D}$, S_{INTA} , S_{INTB} , S_{REF1} , S_{REF2} , and S_{RESET} are set (see Figure 4).

At the completion of an A/D conversion, the charge on the integration capacitor (C_F) is reset with S_{REF1} and

RANGE2	RANGE1	RANGE0	C_F (pF, typ)	INPUT RANGE (pC, typ)
0	0	0	External 12.5 to 250	Up to 1000
0	0	1	12.5	-0.2 to 50
0	1	0	25	-0.4 to 100
0	1	1	37.5	-0.6 to 150
1	0	0	50	-0.8 to 200
1	0	1	62.5	-0.1 to 250
1	1	0	75	-1.2 to 300
1	1	1	87.5	-1.4 to 350

TABLE I. Range Selection of the DDC112.

S_{RESET} (see Figures 4 and 5a). This is done during the reset time. In this manner, the selected capacitor is charged to the reference voltage, V_{REF} . Once the integration capacitor is charged, S_{REF1} and S_{RESET} are switched so that V_{REF} is no longer connected to the amplifier circuit while it waits to begin integrating (see Figure 5b). With the rising edge on CONV, S_{INTA} closes which begins the integration of Channel A. This puts the integrator stage into its integrate mode (see Figure 5c).

Charge from the input signal is collected on the integration capacitor causing the voltage output of the amplifier to decrease. A falling edge CONV stops the integration by switching the input signal from side A to side B (S_{INTA} and S_{INTB}). Prior to the falling edge of CONV, the signal on side B was converted by the A/D converter and reset during the time that side A was integrating. With the falling edge of CONV, side B starts integrating the input signal. Now the output voltage of side A's operational amplifier is presented to the input of the $\Delta\Sigma$ A/D converter (see Figure 5d).

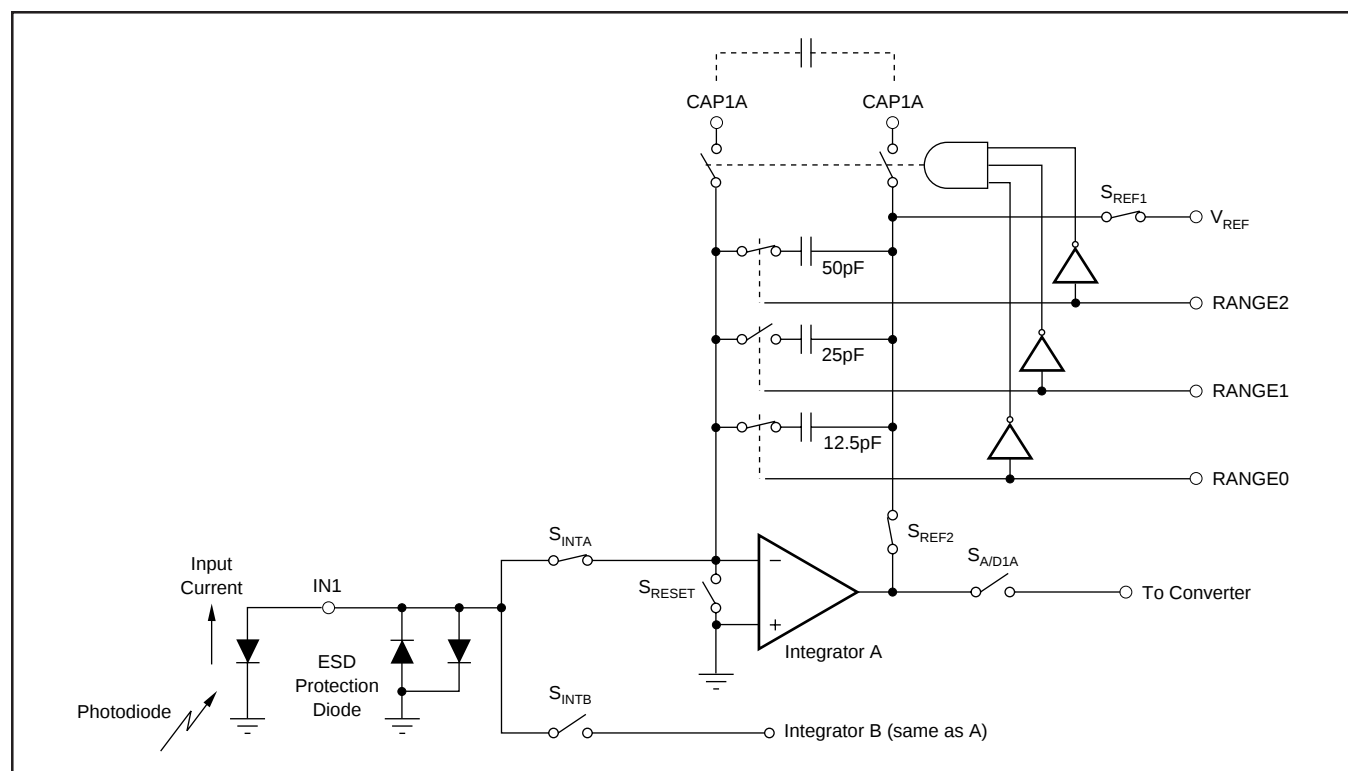


FIGURE 3. Basic Integrator Configuration for Input 1 Shown with a 250pC ($C_F = 62.5$ pF) Input Range.

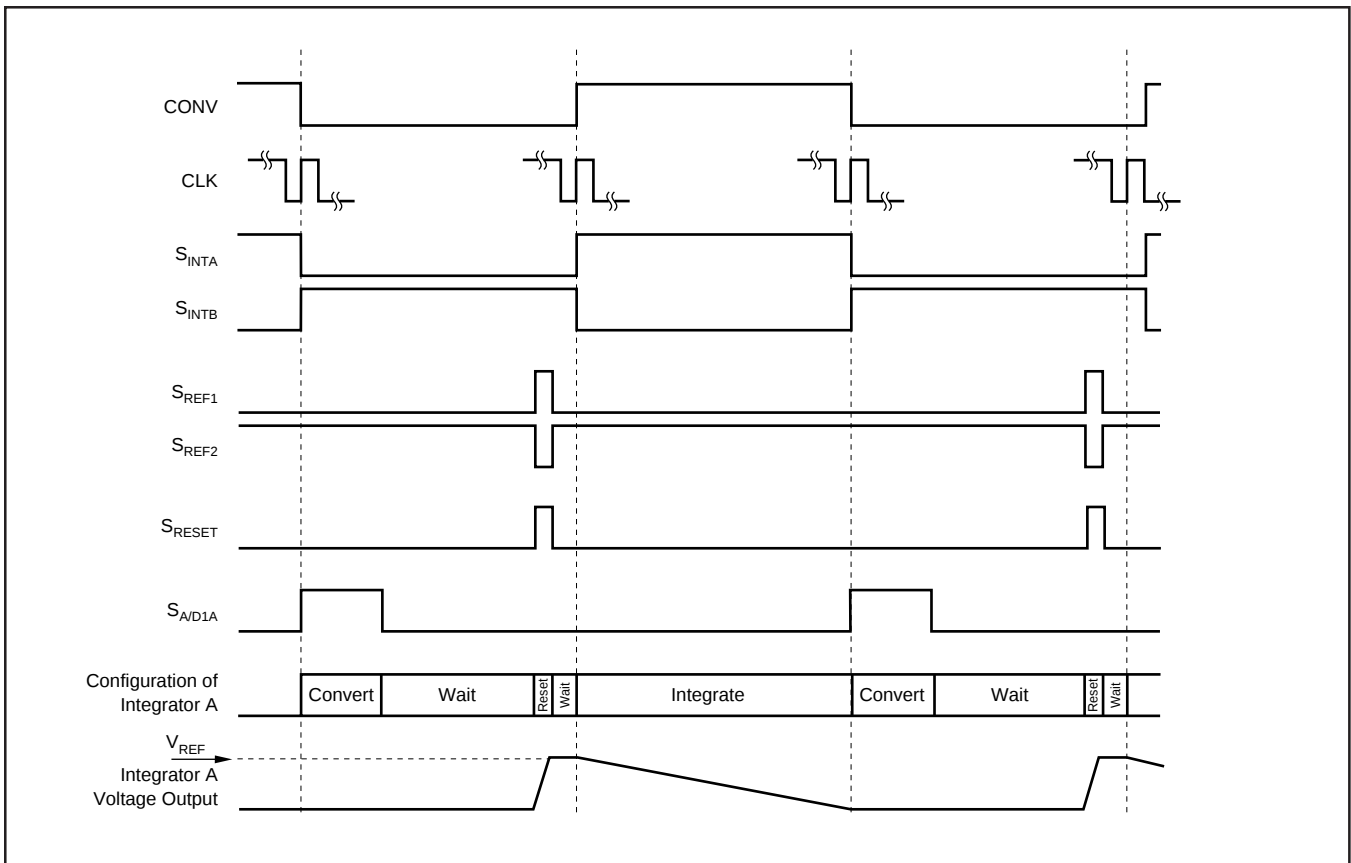


FIGURE 4. Basic Integrator Timing Diagram as Illustrated in Figure 3.

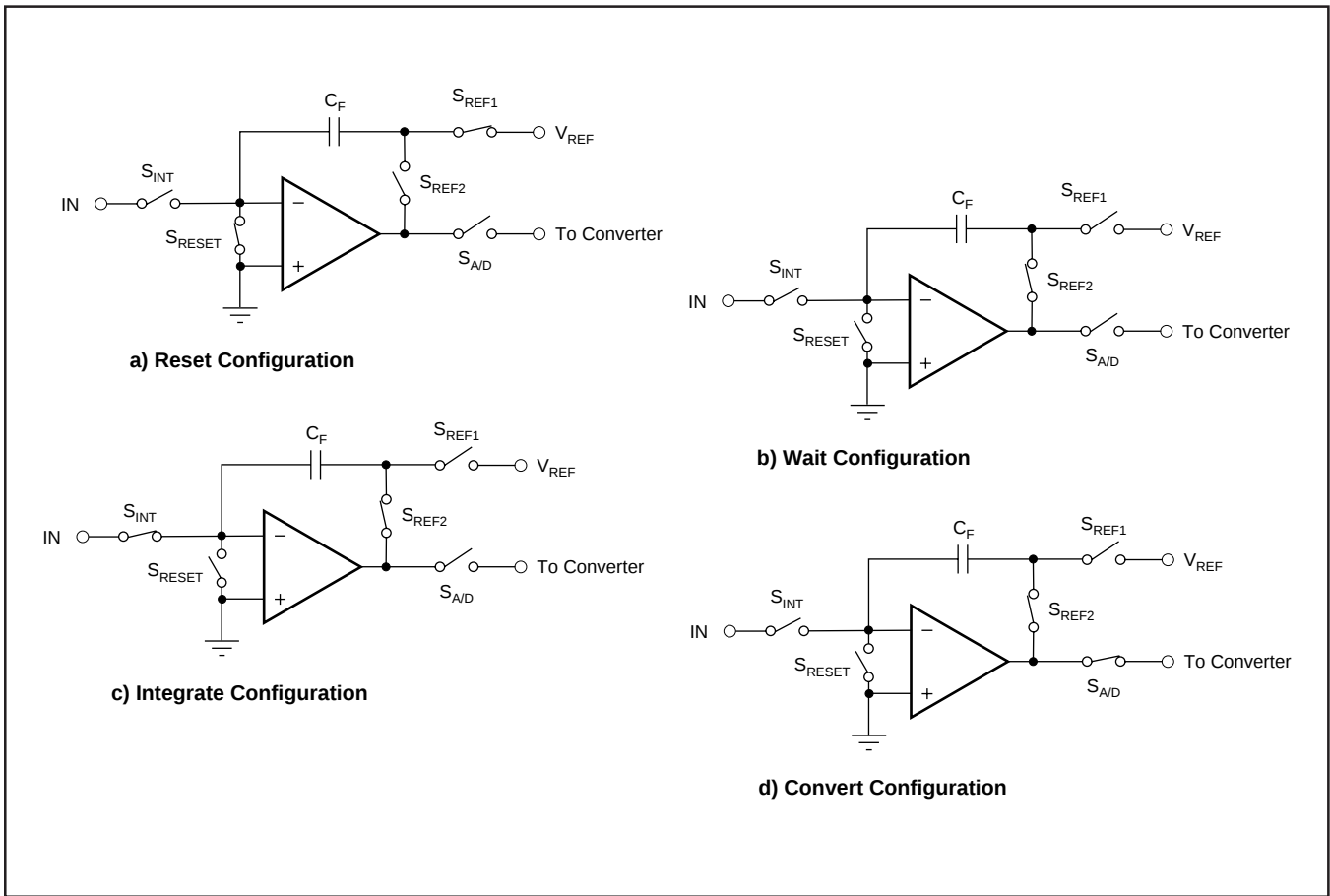


FIGURE 5. Diagrams for the Four Configurations of the Front End Integrators of the DDC112.

Determining the Integration Capacitor (C_F) Value

The value of the integrator's feedback capacitor, the integration period, and the reference voltage determine the positive full-scale (+FS) value of the DDC112. The approximate positive full-scale value of the DDC112 is given by the following equations:

$$\begin{aligned} Q_{IN} &= I_{IN} \cdot T_{INT} \\ Q_{FS} &= (0.96) V_{REF} \cdot C_F \\ I_{FS} &= \frac{(0.96) V_{REF} \cdot C_F}{T_{INT}} \\ \text{or} \\ C_F &= \frac{I_{FS} \cdot T_{INT}}{(0.96) V_{REF}} \end{aligned}$$

The "0.96" factor allows the front end integrators to reach full scale without having to completely swing to ground. The negative full-scale (–FS) range is approximately 0.4% of the positive full-scale range. For example, Range 5 has a nominal +FS range of 250pC. The –FS range is then approximately –1pC. This relationship holds for external capacitors as well and is independent of V_{REF} (for V_{REF} within the allowable range, see the Specification table).

Integration Capacitors

There are seven different capacitors available on chip for each side of each channel in the DDC112. These internal capacitors are trimmed in production to achieve the specified performance for range error of the DDC112. The range control pins (RANGE0–RANGE2) change the capacitor value for all four integrators. Consequently, both inputs and both sides of each input will always have the same full scale range unless external capacitors are used.

External integration capacitors may be used instead of the internal capacitors values by setting RANGE2–RANGE0 = 000. The external capacitor pin connections are summarized in Table II. Usually, all four external capacitors are equal in value, however, it is possible to have differing pairs of external capacitors between Input 1 and Input 2 of the DDC112. Regardless of the selected value of the capacitor, it is strongly recommended that the capacitors for sides A and B be the same.

EXTERNAL CAPACITOR PINS ON THE DDC112	INTEGRATOR	
	Channel	Side
5 and 6	1	A
3 and 4	1	B
23 and 24	2	A
25 and 26	2	B

TABLE II. External Capacitor Connections with Range Configuration of RANGE2–RANGE0 = 000.

Since the range accuracy depends on the characteristics of the integration capacitor, they must be carefully selected. An external integration capacitor should have low voltage coefficient, temperature coefficient, memory, and leakage current. The optimum selection depends on the requirements of the specific application. Suitable types include COG ceramic, polycarbonate, polystyrene, and silver mica.

Voltage Reference

The external voltage reference is used to reset the integration capacitors before an integration cycle begins. It is also used by the $\Delta\Sigma$ converter while the converter is measuring the voltage stored on the integrators after an integration cycle ends. During this sampling, the external reference must supply charge needed by the $\Delta\Sigma$ converter. For an integration time of 500 μ s, this charge translates to an average V_{REF} current of approximately 150 μ A. The amount of charge needed by the $\Delta\Sigma$ converter is independent of the integration time, therefore, increasing the integration time lowers the average current. For example, an integration time of 1000 μ s lowers to average V_{REF} current to 75 μ A.

It is critical that V_{REF} be stable during the different modes of operation shown in Figure 5. The $\Delta\Sigma$ converter measures the voltage on the integrator with respect to V_{REF} . Since the integrator's capacitors are initially reset to V_{REF} , any droop in V_{REF} from the time the capacitors are reset to the time when the converter measures the integrator's output will introduce an offset. It is also important that V_{REF} be stable over longer periods of time as changes in V_{REF} correspond directly to changes in the full-scale range. Finally, V_{REF} should introduce as little additional noise as possible.

For reasons mentioned above, it is strongly recommended that the external reference source be buffered with an operational amplifier, as shown in Figure 6. In this circuit, the voltage reference is generated by a 4.096V reference.

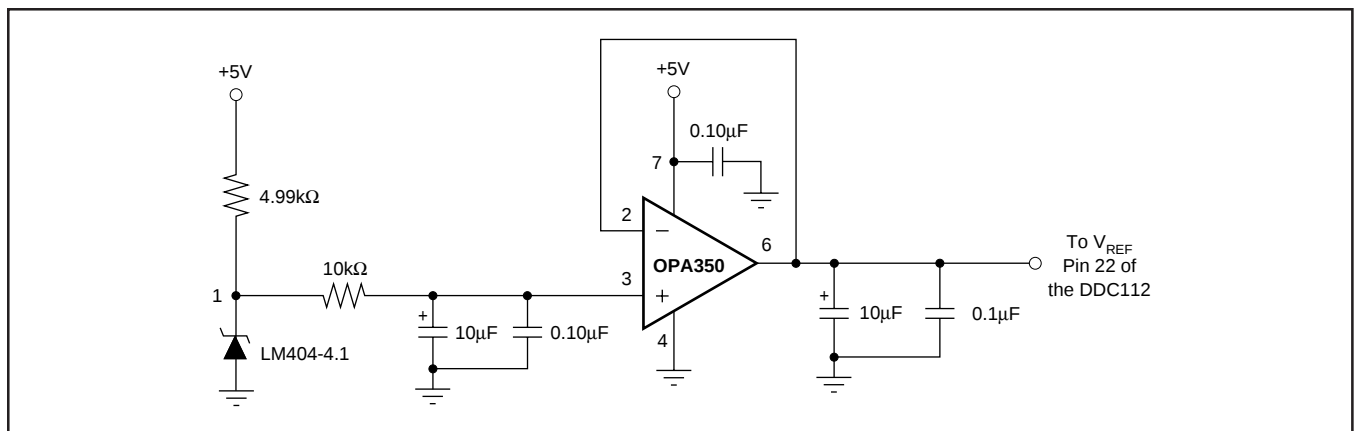


FIGURE 6. Recommended External Voltage Reference Circuit for Best Low Noise Operation with the DDC112.

A low-pass filter to reduce noise connects it to an operational amplifier configured as a buffer. This amplifier should have a unity gain bandwidth greater than 4MHz, low noise, and input/output common-mode ranges that support V_{REF} . Following the buffer are capacitors placed close to the DDC112's V_{REF} pin. Even though the circuit in Figure 6 might appear to be unstable due to the large output capacitors, it works well for most operational amplifiers. It is NOT recommended that series resistance be placed in the output lead to improve stability since this can cause droop in V_{REF} which produces large offsets.

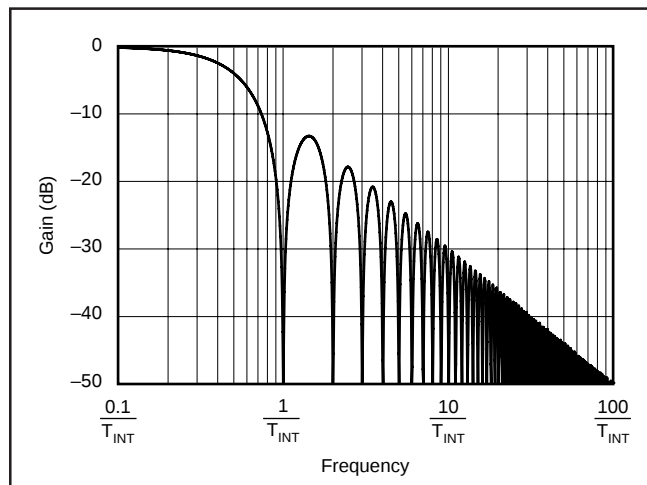


FIGURE 7. Frequency Response of the DDC112.

DDC112 Frequency Response

The frequency response of the DDC112 is set by the front end integrators and is that of a traditional continuous time integrator, as shown in Figure 7. By adjusting T_{INT} , the user can change the 3dB bandwidth and the location of the notches in the response. The frequency response of the $\Delta\Sigma$ converter that follows the front end integrator is of no consequence because the converter samples a held signal from the integrators. That is, the input to the $\Delta\Sigma$ converter is always a DC signal. Since the output of the front end integrators are sampled, aliasing can occur. Whenever the frequency of the input signal exceeds one-half of the sampling rate, the signal will “fold” back down to lower frequencies.

Test Mode

When TEST is used, pins IN1 and IN2 are grounded and “packets” of approximately 13pC charge are transferred to the integration capacitors of both Input 1 and Input 2. This fixed charge can be transferred to the integration capacitors either once during an integration cycle or multiple times. In the case where multiple packets are transferred during one integration period, the 13pC charge is additive. This mode can be used in both the continuous and non-continuous mode timing. The timing diagrams for test mode are shown in Figure 8. The top three lines in Figure 8 define the timing when one packet of 13pC is sent to the integration capacitors. The bottom three lines define the timing when multiple packets are sent to the integration capacitors.

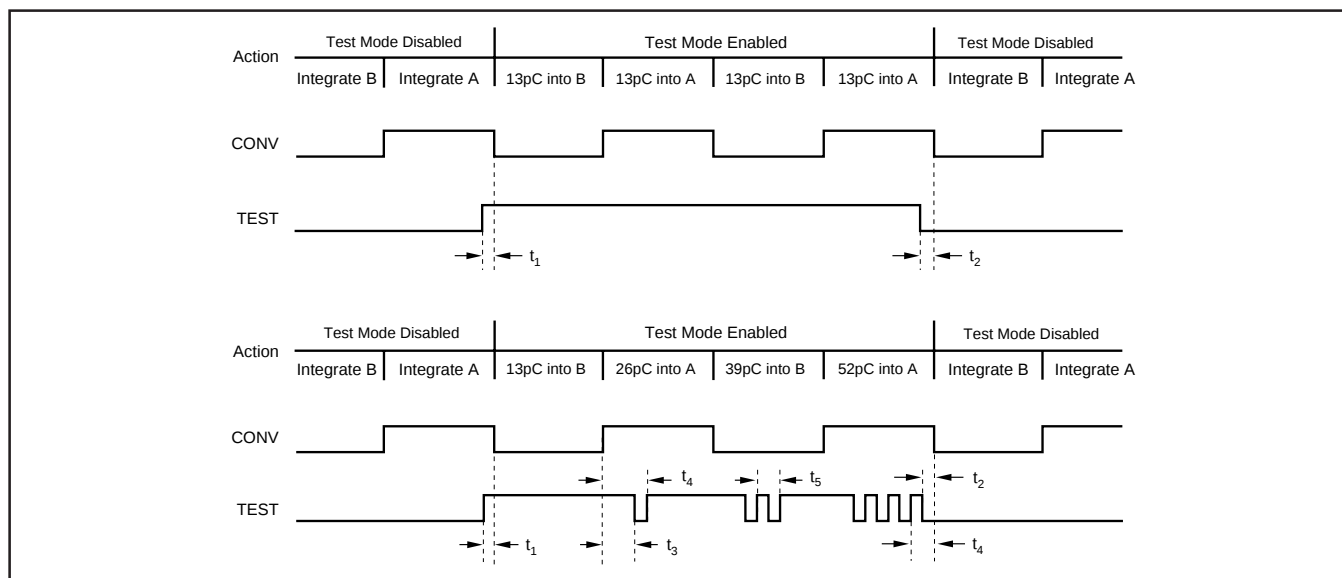


FIGURE 8. Timing Diagram of the Test Mode of the DDC112.

SYMBOL	DESCRIPTION	CLK = 10MHz			CLK = 15MHz			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
t_1	Setup Time for Test Mode Enable	100			100			ns
t_2	Setup Time for Test Mode Disable	100			100			ns
t_3	Hold Time for Test Mode Enable	100			100			ns
t_4	From Rising Edge of TEST to the Edge of CONV while Test Mode Enabled	5.4			3.6			μ s
t_5	Rising Edge to Rising Edge of TEST	5.4			3.6			μ s

TABLE III. Timing for the DDC112 in the Test Mode.

TEST and CONV work together to implement this feature. The test mode is entered when TEST is HIGH prior to a CONV edge. At that point, a CONV edge triggers the grounding of the analog inputs and the switching of 13pC packets of charge onto the integration capacitors. If TEST is kept HIGH through at least two conversions (i.e., a rise and fall of CONV), all four integrators will be charged with a 13pC packet. At the end of each conversion, the voltage at the output of the integrators is digitized as discussed in the “Continuous Mode” and “Non-Continuous Mode” section of this data sheet. The test mode is exited when TEST is LOW and a CONV edge occurs.

Once the test mode is entered as described above, TEST can cycle as many times as desired. When this is done, additional 13pC packets are added on the rising edge of TEST to the existing charge on the integrator capacitors. Multiple charge packets can be added in this way as long as the TEST pin is not LOW when CONV toggles.

DIGITAL ISSUES

The digital interface of the DDC112 provides the digital results via a synchronous serial interface consisting of a data clock (DCLK), a transmit enable pin (DXMIT), a valid data pin (DVALID), a serial data output pin (DOUT), and a serial data input pin (DIN). The DDC112 contains only one A/D converter, so the conversion process is interleaved between the two inputs (see Figure 2). The integration and conversion process is fundamentally independent of the data retrieval process. Consequently, the CLK frequency and DCLK frequencies need not be the same. DIN is used when multiple converters are cascaded. Cascading or “daisy chaining” greatly simplifies the interconnection and routing of the digital outputs in cases where a large number of converters are needed. Refer to “Cascading Multiple Converters” section of this data sheet for more detail.

The conversion rate of the DDC112 is set by a combination of the integration time (determined by the user) and the speed of the A/D conversion process. The A/D conversion time is primarily a function of the system clock (CLK) speed. One A/D conversion cycle encompasses the conversion of two signals (one from each input of the DDC112) and reset time for each of the integrators involved in the two conversions. In most situations, the A/D conversion time is shorter than the integration time. If this condition exists, the DDC112 will operate in the continuous mode. When the DDC112 is in the continuous mode, the sensor output is continuously integrated by one of the two sides of each input.

In the event that the A/D conversion takes longer than the integration time, the DDC112 will switch into a non-continuous mode. In non-continuous mode, the A/D converter is not able to keep pace with the speed of the integration process. Consequently, the integration process is periodically halted until the digitizing process catches up. These two basic modes of operation for the DDC112—continuous and non-continuous modes—are described below.

Continuous and Non-Continuous Operational Modes

The state diagram of the DDC112 is shown in Figure 9. In all, there are 8 states. Table IV provides a brief explanation of each of the states.

STATE	MODE	DESCRIPTION
1	Ncont	Complete m/r/az of side A, then side B (if previous state is state 4). Initial power-up state when CONV is initially held HIGH.
2	Ncont	Prepare side A for integration.
3	Cont	Integrate on side A.
4	Cont	Integrate on side B; m/r/az on side A.
5	Cont	Integrate on side A; m/r/az on side B.
6	Cont	Integrate on side B.
7	Ncont	Prepare side B for integration.
8	Ncont	Complete m/r/az of side B, then side A (if previous state is state 5). Initial power-up state when CONV is initially held LOW.

TABLE IV. State Descriptions.

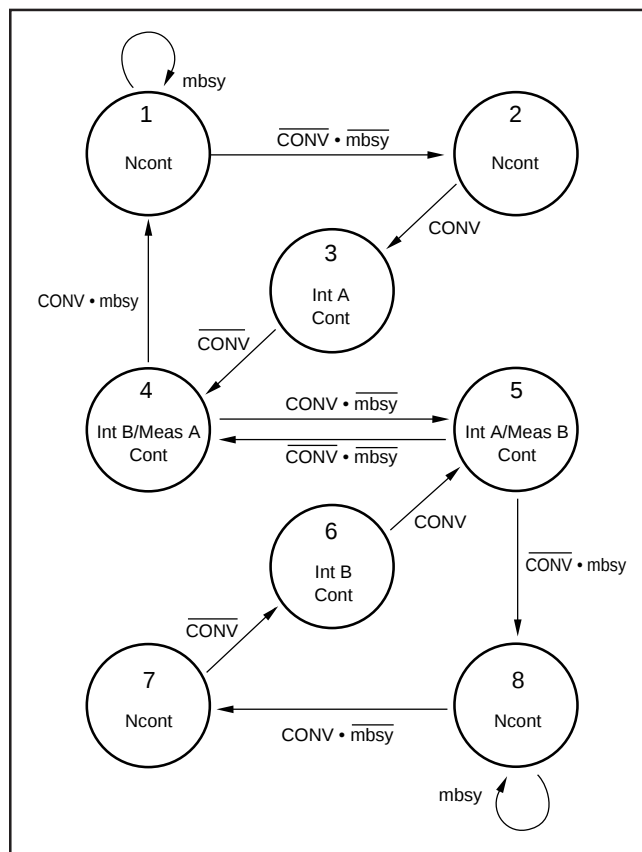


FIGURE 9. State Diagram.

Four signals are used to control progression around the state diagram: CONV and mbsy and their complements. The state machine uses the level as opposed to the edges of CONV to control the progression. mbsy is an internally generated signal not available to the user. It is active whenever a measurement/reset/auto-zero (m/r/az) cycle is in progress.

When power is first applied to the DDC112, the beginning state is either 1 or 8, depending on the initial level of CONV. For CONV held HIGH at power-up, the beginning state is 1. Conversely, for CONV held LOW at power-up, the beginning state is 8. In general, there is a symmetry in the state diagram between states 1-8, 2-7, 3-6 and 4-5. Inverting CONV results in the states progressing through their symmetrical match.

A few timing diagrams will now be discussed to help illustrate the operation of the state machine. These are shown in Figures 10 through 19. Table V gives generalized timing specifications in units of CLK periods. Values in μs

In Figure 10, the first state is ncont state 1. The DDC112 always powers up in the ncont mode. In this case, the first state is 1 because CONV is initially HIGH. After the first two states, cont mode operation is reached and the states begin toggling between 4 and 5. From now on, the input is being continuously integrated, either by side A or side B.

The time needed for the m/r/az cycle, t_6 , is the same time that determines the boundary between the cont and ncont modes described earlier in the Overview section. $\overline{\text{DVALID}}$ goes LOW after CONV toggles in time t_1 , indicating that data is ready to be retrieved. As shown in Figure 10, there are two values for t_7 , depending on T_{INT} . The reason for this will be discussed in the Special Considerations section.

Figure 11 shows the result of inverting the logic level of CONV. The only difference is in the first three states. Afterwards, the states toggle between 4 and 5 just as in the previous example. Figure 12 shows the timing diagram of the internal operations occurring during continuous mode operation.

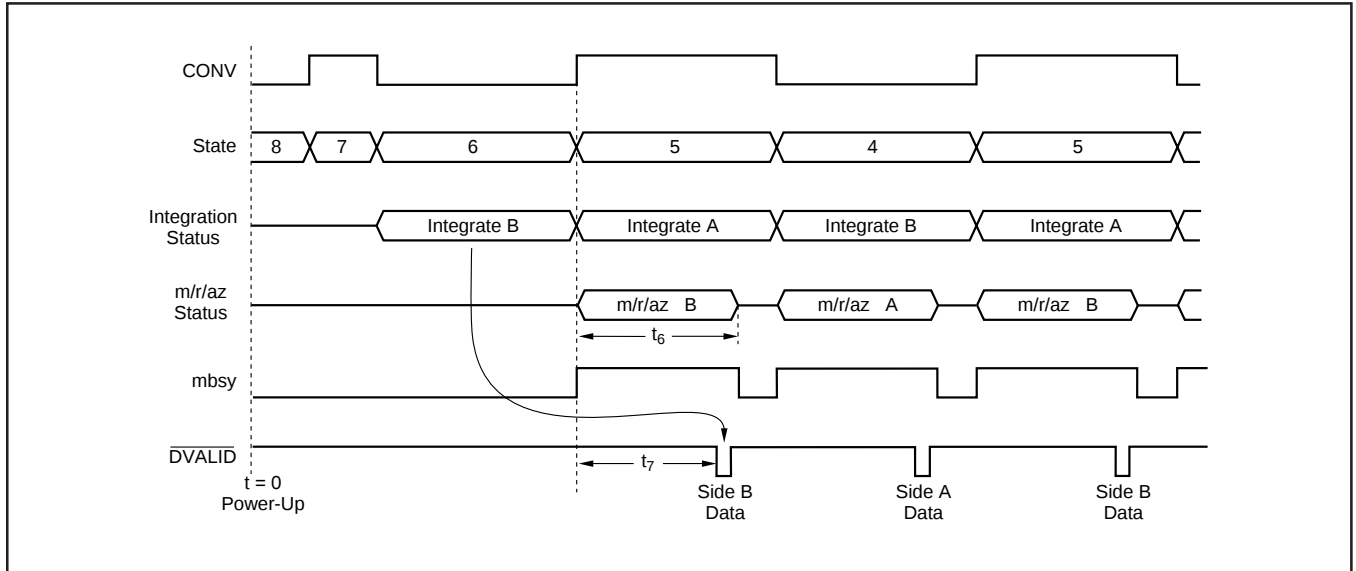


FIGURE 11. Continuous Mode Timing (CONV LOW at power-up).

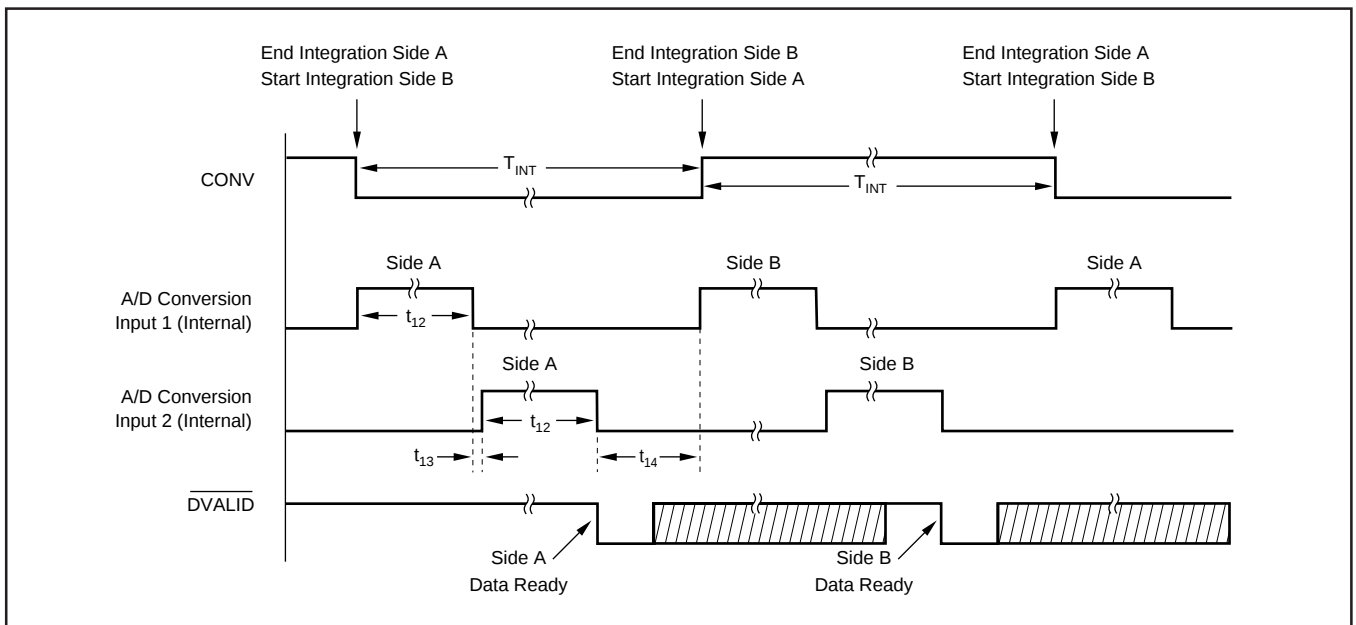


FIGURE 12. Timing Diagram of the Internal Operation in Continuous Mode of the DDC112.

SYMBOL	DESCRIPTION	CLK = 10MHz			CLK = 15MHz			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
T_{INT}	Integration Period (continuous mode)	500		1,000,000	333		1,000,000	μs
t_{12}	A/D Conversion Time (internally controlled)		202.2			134.66		μs
t_{13}	A/D Conversion Reset Time (internally controlled)		13.2			8.8		μs
t_{14}	Integrator and A/D Conversion Reset Time (internally controlled)		61.8			41.2		μs

TABLE VI. Timing for the Internal Operation in the Continuous Mode.

Ncont Mode

Figure 13 illustrates operation in the ncont mode. The integrations come in pairs (i.e., sides A/B or sides B/A) followed by a time during which no integrations occur. During that time, the previous integrations are being measured, reset and auto-zeroed. Before the DDC112 can advance to states 3 or 6, both sides A and B must be finished with the m/r/az cycle which takes time t_{10} . When the m/r/az cycles are completed, time t_{11} is needed to prepare the next side for integration. This time is required for the ncont mode because the m/r/az cycle of the ncont mode is slightly different from that of the cont mode. After the first integration ends, $\overline{\text{DVALID}}$ goes LOW in time t_8 . This is the same

time as in the cont mode. The second data will be ready in time t_9 after the first data is ready. One result of the naming convention used in this application bulletin is that when the DDC112 is operating in the “ncont mode”, it passes through both “ncont mode states” and “cont mode states”. For example, in Figure 13, the state pattern is 3, 4, 1, 2, 3, 4, 1, 2, 3, 4...where 3 and 4 are cont mode states. “Ncont mode” by definition means that for some portion of the time, neither side A nor B is integrating. States that perform an integration are labeled “cont mode states” while those that do not are called “ncont mode states”. Since integrations are performed in the ncont mode, just not continuously, some cont mode states must be used in a ncont mode state pattern.

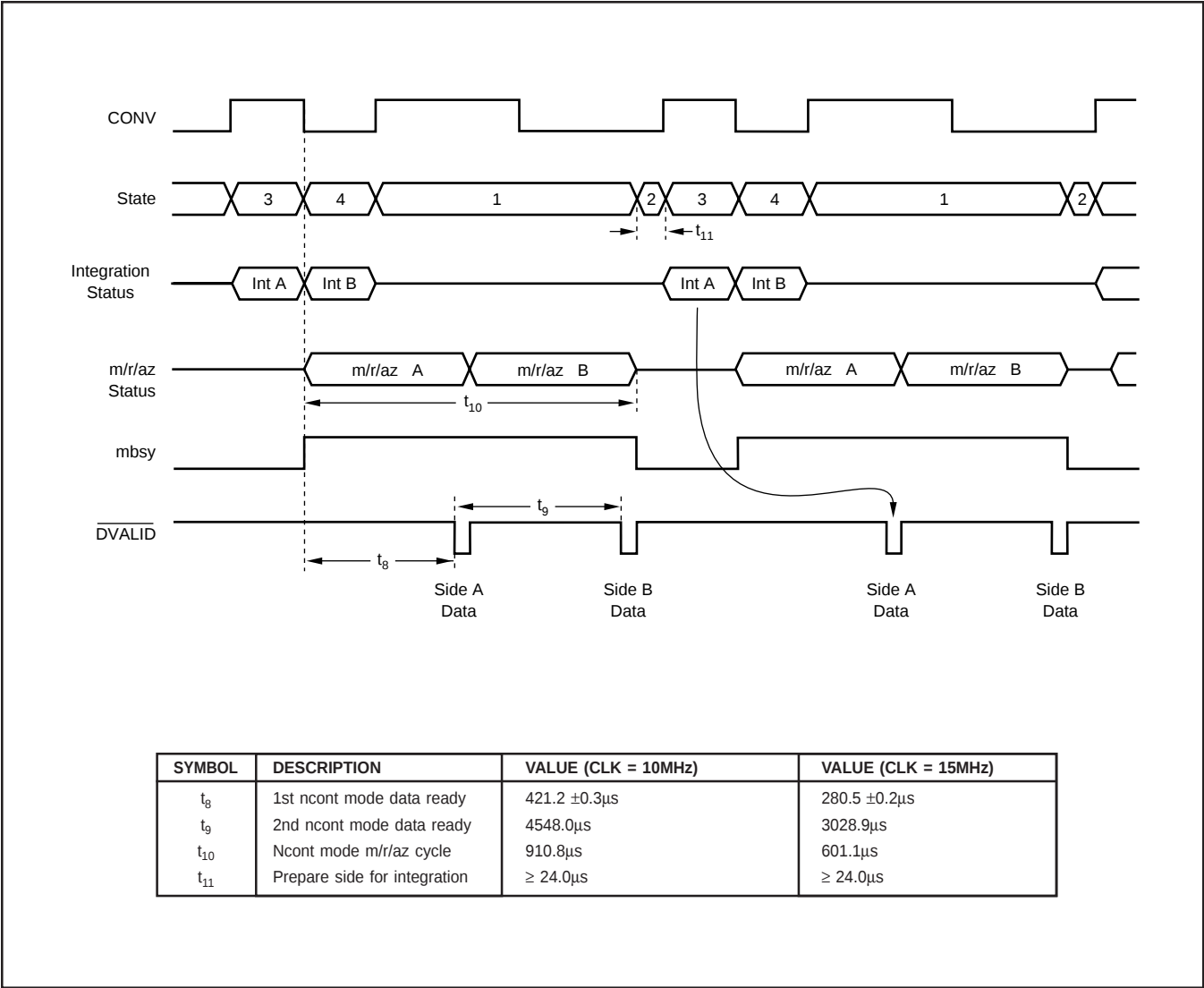


FIGURE 13. Non-Continuous Mode Timing.

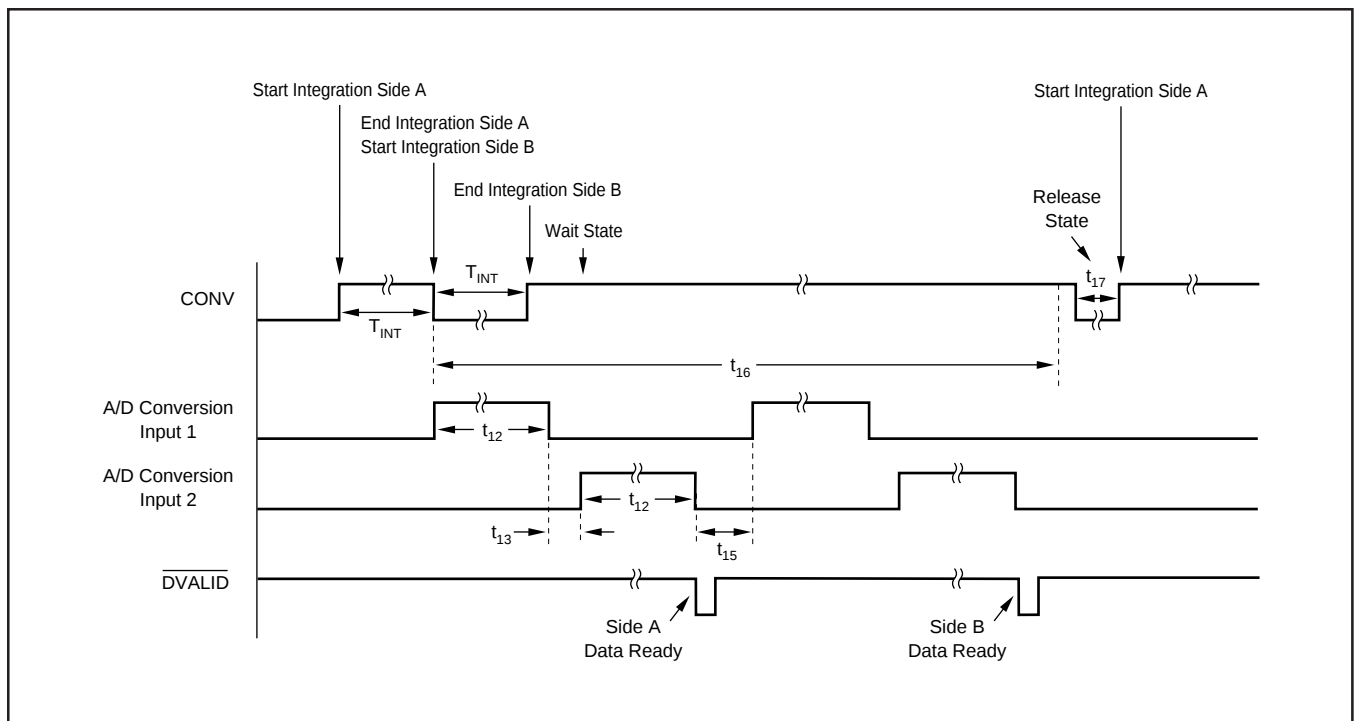


FIGURE 14. Conversion Detail for the Internal Operation of the Non-Continuous Mode with Side A Integrated First.

SYMBOL	DESCRIPTION	CLK = 10MHz			CLK = 15MHz			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
T_{INT}	Integration Time (non-continuous mode)	50		1,000,000	50		1,000,000	μ S
t_{12}	A/D Conversion Time (internally controlled)		202.2			134.6		μ S
t_{13}	A/D Conversion Reset Time (internally controlled)		13.2			8.8		μ S
t_{15}	Integrator and A/D Conversion Reset Time (internally controlled)		37.8			25.2		μ S
t_{16}	Total A/D Conversion and Rest Time (internally controlled)		910.8			606.6		μ S
t_{17}	Release Time	24			24			μ S

TABLE VII. Internal Timing for the DDC112 in the Non-Continuous Mode.

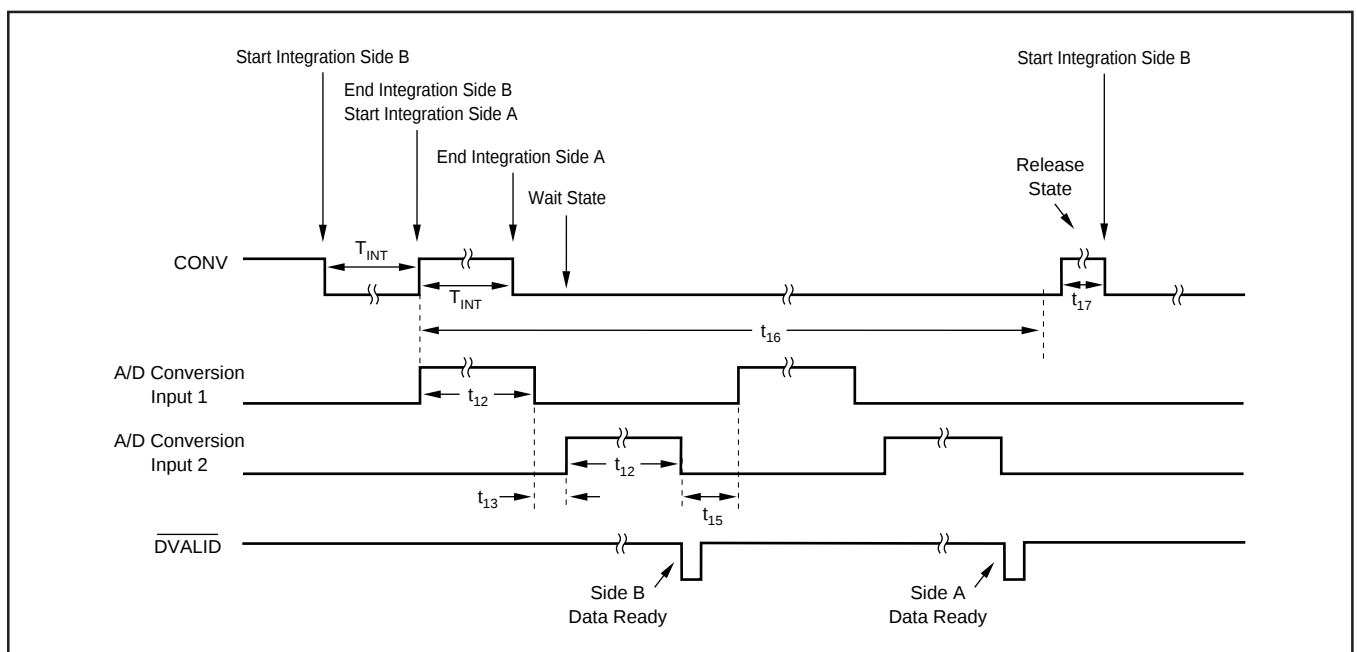


FIGURE 15. Internal Operation Timing Diagram of the Non-Continuous Mode with Side B Integrated First.

Looking at the state diagram, one can see that the CONV pattern needed to generate a given state progression is not unique. Upon entering states 1 or 8, the DDC112 remains in those states until mbsy goes LOW, independent of CONV. As long as the m/r/az cycle is underway, the state machine ignores CONV (see Figure 9). The top two signals are different CONV patterns that produce the same state. This feature can be a little confusing at first, but it does allow flexibility in generating ncont mode CONV patterns. For example, the DDC112 Evaluation Fixture operates in the ncont mode by generating a square wave with pulse width $< t_6$. Figure 17 illustrates operation in the ncont mode

using a 50% duty cycle CONV signal with $T_{INT} = 1620$ CLK periods. Care must be exercised when using a square wave to generate CONV. There are certain integration times that must be avoided since they produce very short intervals for state 2 (or state 7 if CONV is inverted). As seen in the state diagram, the state progresses from 2 to 3 as soon as CONV is HIGH. The state machine does not insure that the duration of state 2 is long enough to properly prepare the next side for integration (t_{11}). This must be done by the user with proper timing of CONV. For example, if CONV is a square wave with $T_{INT} = 3042$ CLK periods, state 2 will only be 18 CLK periods long, therefore, t_{11} will not be met.

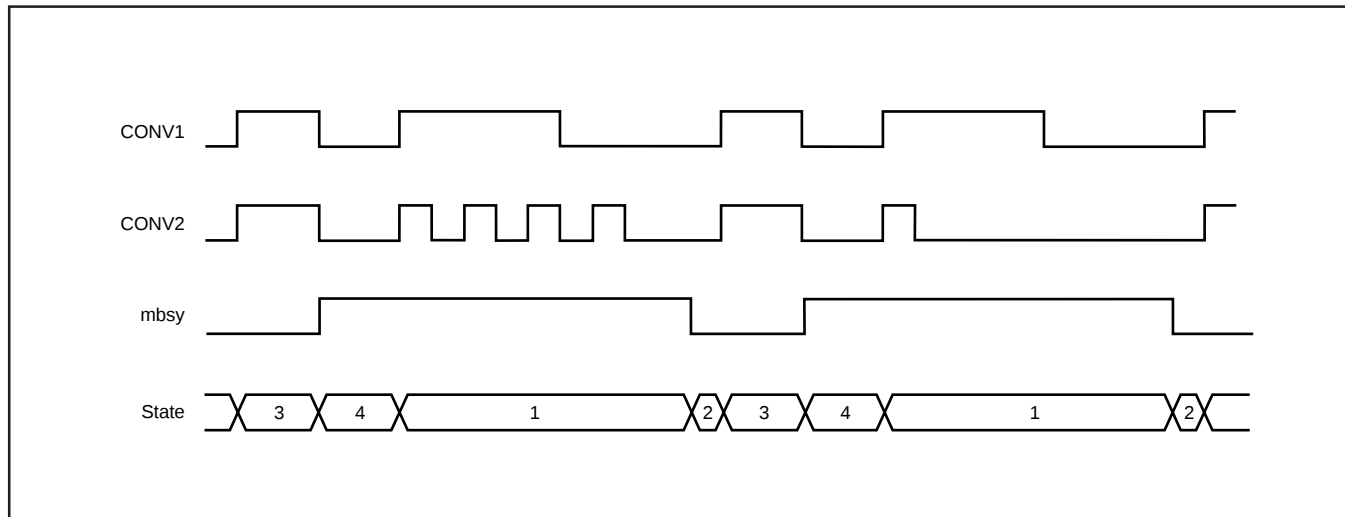


FIGURE 16. Equivalent CONV Signals in Non-Continuous Mode.

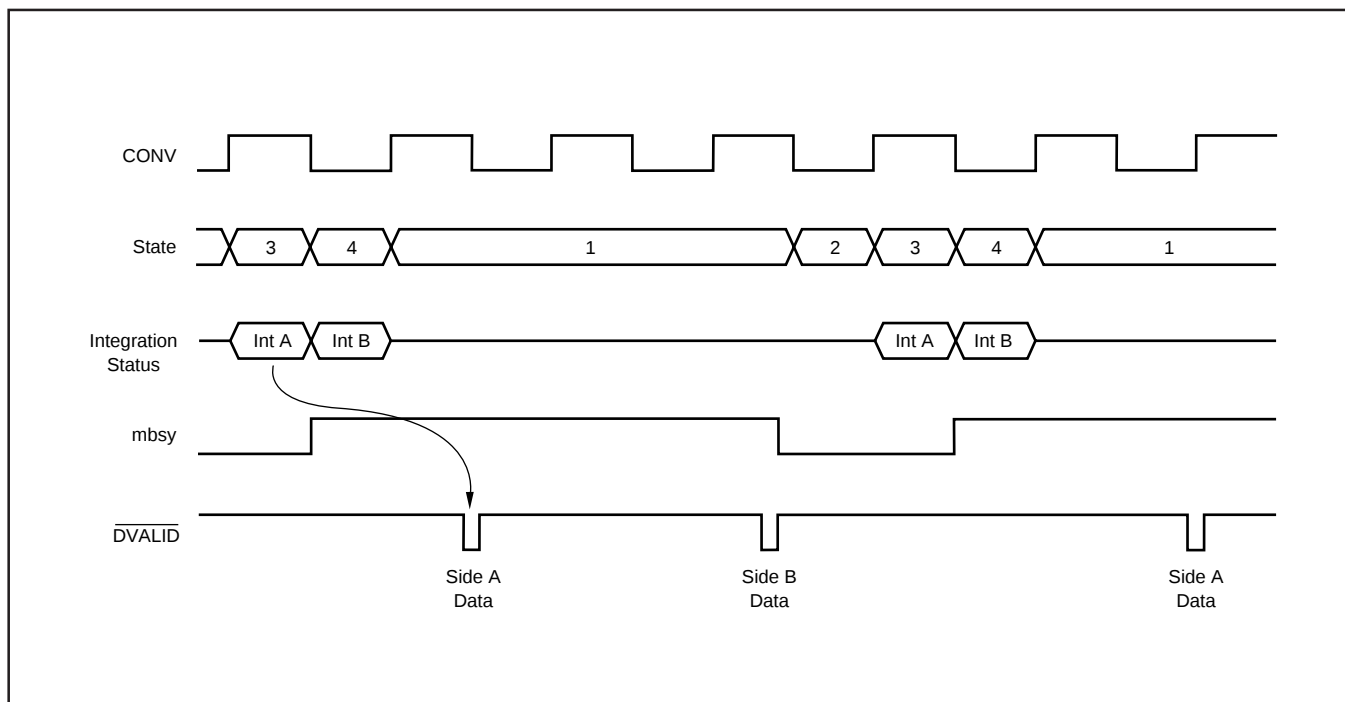


FIGURE 17. Non-Continuous Mode Timing with a 50% Duty Cycle CONV Signal.

Changing Between Modes

Changing from the cont to ncont mode occurs whenever $T_{INT} < t_6$. Figure 18 shows an example of this transition. In this figure, the cont mode is entered when the integration on side A is completed before the m/r/az cycle on side B is complete. The DDC112 completes the measurement on sides B and A during states 8 and 7 with the input signal shorted to ground. Ncont integration begins with state 6.

Changing from the ncont to cont mode occurs when T_{INT} is increased so that T_{INT} is always $\geq t_6$ (see Figure 14). With a longer T_{INT} , the m/r/az cycle has enough time to finish before the next integration begins and continuous integration of the input signal is possible. For the special case of the very first integration when changing to the cont mode, T_{INT} can be $< t_6$. This is allowed because there is no simultaneous m/r/az cycle on the side B during state 3—there is no need to wait for it to finish before ending the integration on side A.

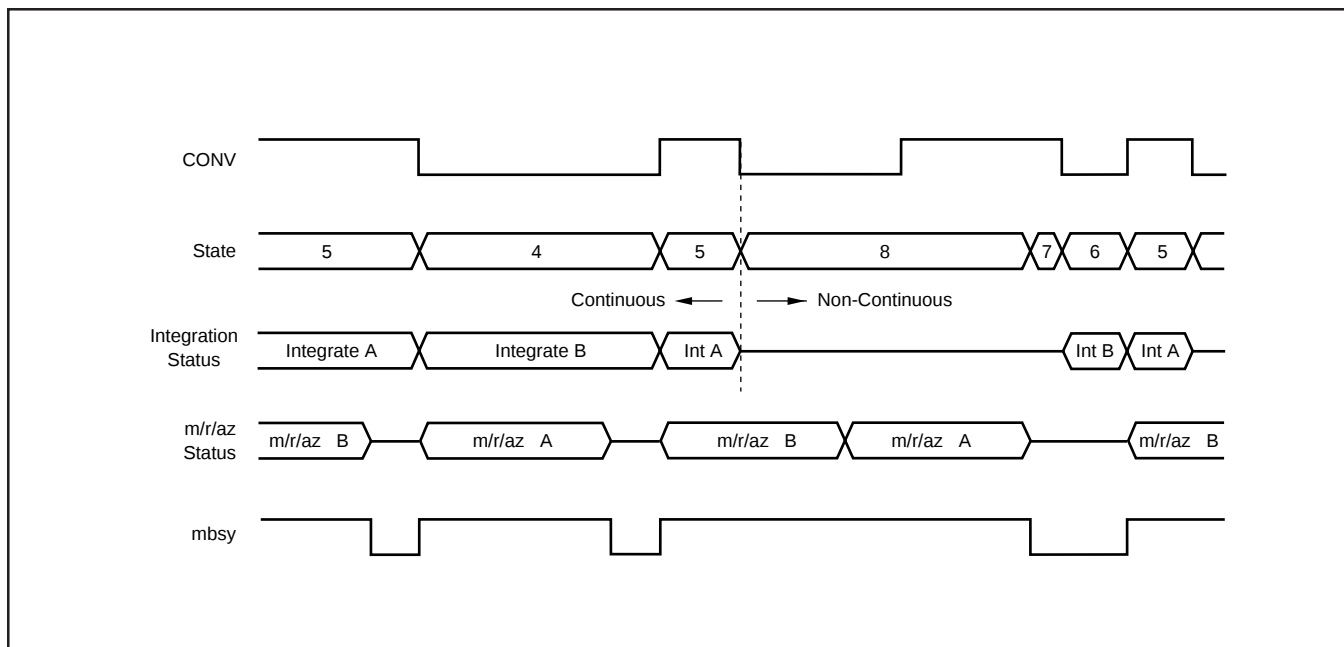


FIGURE 18. Changing from Continuous Mode to Non-Continuous Mode.

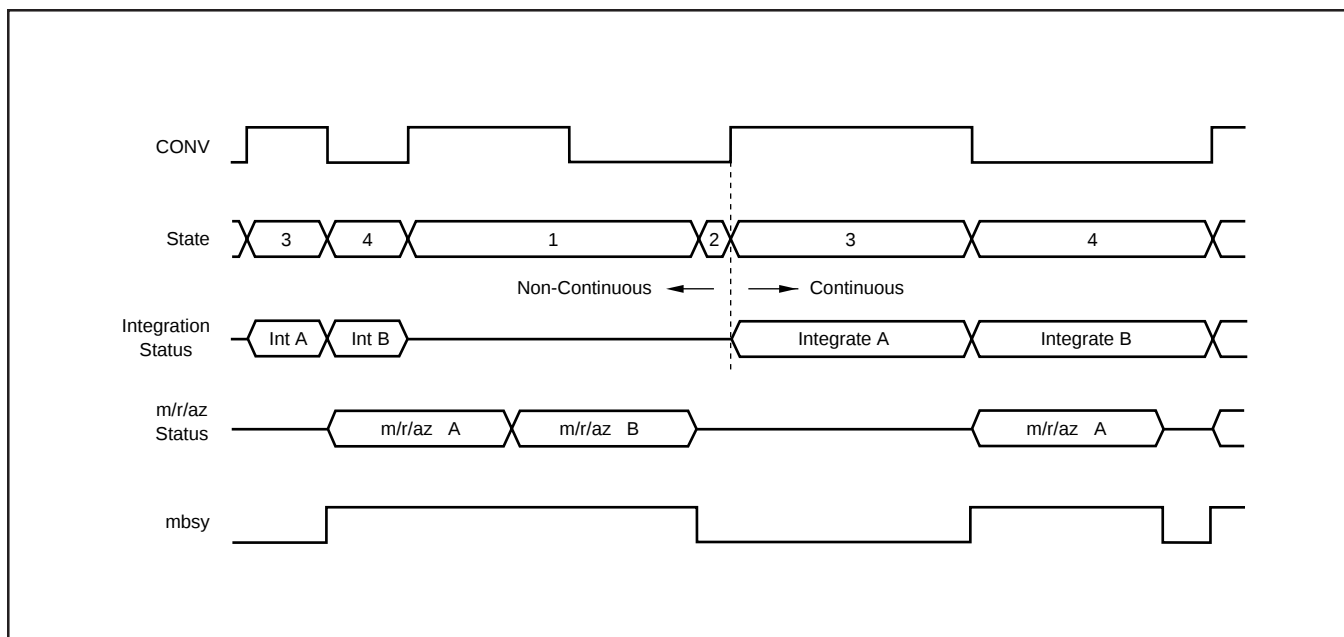


FIGURE 19. Changing from Non-Continuous Mode to Continuous Mode.

SPECIAL CONSIDERATIONS

NCONT MODE INTEGRATION TIME

The DDC112 uses a relatively fast clock. For $CLK = 10MHz$, this allows T_{INT} to be adjusted in steps of 100ns since CONV should be synchronized to CLK. However, for the internal measurement, reset and auto-zero operations, a slower clock is more efficient. The DDC112 divides CLK by six and uses this slower clock with a period of 600ns to run the m/r/az cycle and data ready logic.

Because of the divider, it is possible for the integration time to be a non-integer number of slow clock periods. For example, if $T_{INT} = 5000 CLK$ periods (500μs for $CLK = 10MHz$), there will be 833 1/3 slow clocks in an integration period. This non-integer relationship between T_{INT} and the slow clock period causes the number of rising and falling slow clock edges within an integration period to change from integration to integration. The digital coupling of these edges to the integrators will in turn change from integration to integration which produces noise. The change in the clock edges is not random, but will repeat every 3 integrations. The coupling noise on the integrators appears as a tone with a frequency equal to the rate at which the coupling repeats.

To avoid this problem in cont mode, the internal slow clock is shut down after the m/r/az cycle is complete when it is no longer needed. It starts up again just after the next integration begins. Since the slow clock is always off when CONV toggles, the same number of slow clock edges fall within an integration period regardless of its length. Therefore, $T_{INT} \geq 4794 CLK$ periods will not produce the coupling problem described above.

For the ncont mode however, the slow clock must always be left running. The m/r/az cycle is not completed before an integration ends. It is then possible to have digital coupling to the integrators. The digital coupling noise depends heavily on the layout of the printed circuit board used for the DDC112. For solid grounds and power supplies with good bypassing, it is possible to greatly reduce the coupling. However, for guaranteeing the best performance in the ncont mode, the integration time should be chosen to be an integer multiple of $1/(2f_{SLOWCLOCK})$. For $CLK = 10MHz$, the integration time should be an integer multiple of 300ns— $T_{INT} = 100μs$ is not. A better choice would be $T_{INT} = 99μs$.

DATA READY

The $\overline{DVALID}$ signal which indicates that data is ready is generated using the internal slow clock. The phase relationship between this clock and CLK is set when power is first applied and is random. Since CONV is synchronized with CLK, it will have a random phase relationship with respect to the slow clock. When $T_{INT} > t_6$, the slow clock will temporarily shut down as described above. This shutdown process synchronizes the internal clock with CONV so that the time between when CONV toggles to when $\overline{DVALID}$ goes LOW (t_7 and t_8) is fixed.

For $T_{INT} \leq t_6$, the internal slow clock, is not allowed to shut down and the synchronization never occurs. Therefore, the time between CONV toggling and $\overline{DVALID}$ indicating data is ready has uncertainty due to the random phase relationship between CONV and the slow clock. This variation is $\pm 1/(2f_{SLOWCLOCK})$ or $\pm 3/f_{CLK}$. The timing to the second $\overline{DVALID}$ in the ncont mode will not have a variation since it is triggered off the first data ready (t_9) and both are derived from the slow clock.

Polling $\overline{DVALID}$ to determine when data is ready eliminates any concern about the variation in timing since the readback is automatically adjusted as needed. If the data readback is triggered off the toggling of CONV directly (instead of polling), then waiting the maximum value of t_7 or t_8 insures that data will always be ready before readback occurs.

Data Retrieval

In the continuous and non-continuous modes of operation, the data from the last conversion is available for retrieval with the falling edge of $\overline{DVALID}$ (see Figure 22). The falling edge of $\overline{DXMIT}$ in combination with the data clock (DCLK) will initiate the serial transmission of the data from the DDC112. Typically, data is retrieved from the DDC112 as soon as $\overline{DVALID}$ falls and completed before the next CONV transition from HIGH to LOW or LOW to HIGH occurs. If this is not the case, care should be taken to stop activity on DCLK and consequently DOUT by at least 10μs around a CONV transition. If this caution is ignored it is possible that the integration that is being initiated by CONV will have additional noise introduced.

The serial output data at DOUT is transmitted in Straight Binary Code per Table VIII. An output offset has been built into the DDC112 to allow for the measurement of input signals near and below zero. Board leakage up to $\approx -0.4\%$ of the positive full scale can be tolerated before the digital output clips to all zeroes.

CODE	INPUT SIGNAL
1111 1111 1111 1111 1111	FS
1111 1111 1111 1111 1110	FS – 1LSB
0000 0001 0000 0000 0001	+1LSB
0000 0001 0000 0000 0000	Zero
0000 0000 0000 0000 0000	–0.4% FS

TABLE VIII. Straight Binary Code Table.

Cascading Multiple Converters

Multiple DDC112 units can be connected in serial or parallel configurations, as illustrated in Figures 20 and 21.

DOUT can be used with DIN to “daisy chain” several DDC112 devices together to minimize wiring. In this mode of operation, the serial data output is shifted through multiple DDC112s, as illustrated in Figure 20.

R_{PULLUP} prevents DIN from floating when $\overline{DXMIT}$ is HIGH. Care should be taken to keep the capacitive load on DOUT as low as possible when running $CLK=15MHz$.

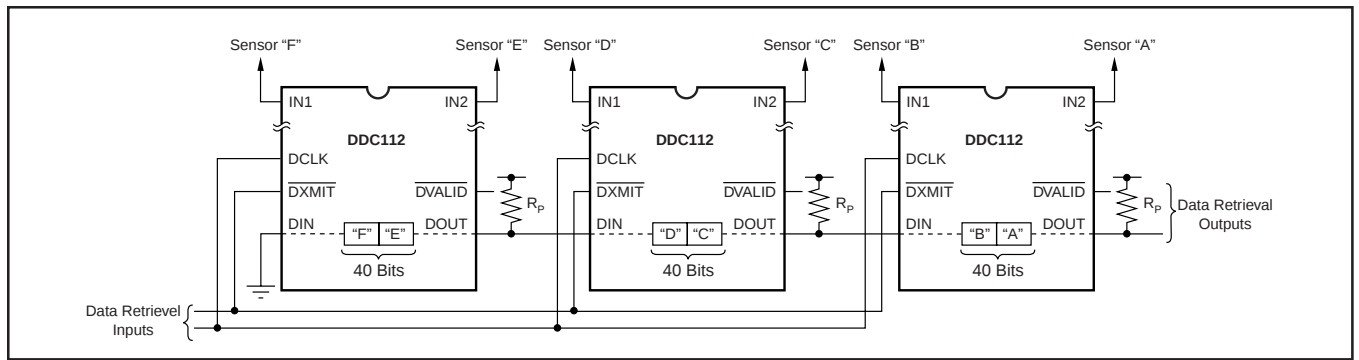


FIGURE 20. Daisy-Chained DDC112's.

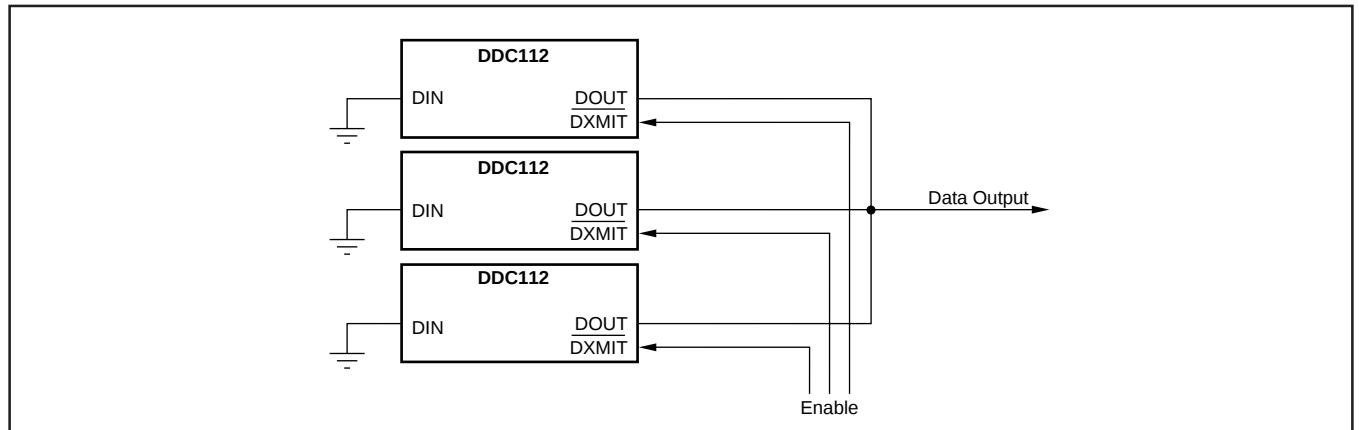


FIGURE 21. DDC112 in Parallel Operation.

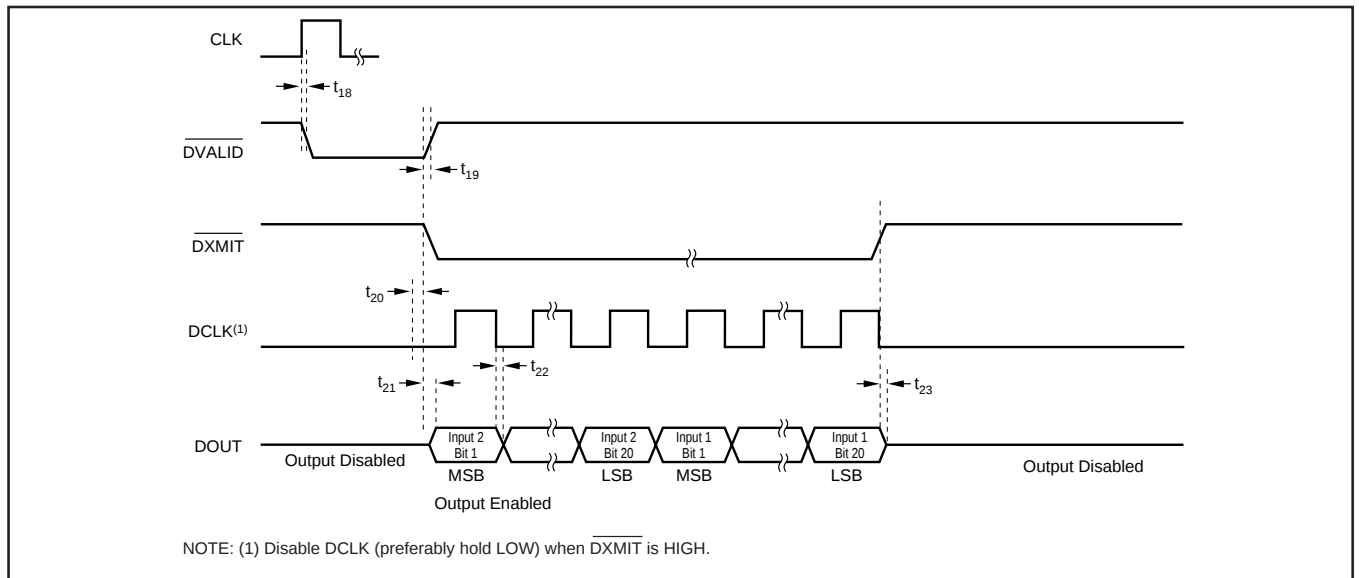


FIGURE 22. Digital Interface Timing Diagram for Data Retrieval From a Single DDC112.

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNITS
t_{18}	Propagation Delay from Rising Edge of CLK to $\overline{\text{DVALID}}$ LOW	30			ns
t_{19}	Propagation Delay from $\overline{\text{DXMIT}}$ LOW to $\overline{\text{DVALID}}$ HIGH	30			ns
t_{20}	Setup Time from DCLK LOW TO $\overline{\text{DXMIT}}$ LOW		20		ns
t_{21}	Propagation Delay from $\overline{\text{DXMIT}}$ LOW to Valid DOUT			30	ns
t_{22}	Hold Time that DOUT is Valid After Falling Edge of DCLK	5			ns
t_{23}	Propagation Delay from $\overline{\text{DXMIT}}$ HIGH to DOUT Disabled		30		ns
$t_{22A}^{(1)}$	Propagaton Delay from Falling Edge of DCLK to Valid DOUT			25	ns
$t_{22B}^{(2)}$	Propagation Delay from Falling Edge of DCLK to Valid DOUT			30	ns

NOTES: (1) Applies to DDC112UK only, with a maximum load of one DDC112UK DIN (4pF typical) with an additional load of (5pF || 100kΩ). (2) Applies to DDC112U only, with a maximum load of one DDC112U DIN (4pF typical) with an additional load of (5pF || 100kΩ).

TABLE IX. Timing for the DDC112 Data Retrieval.

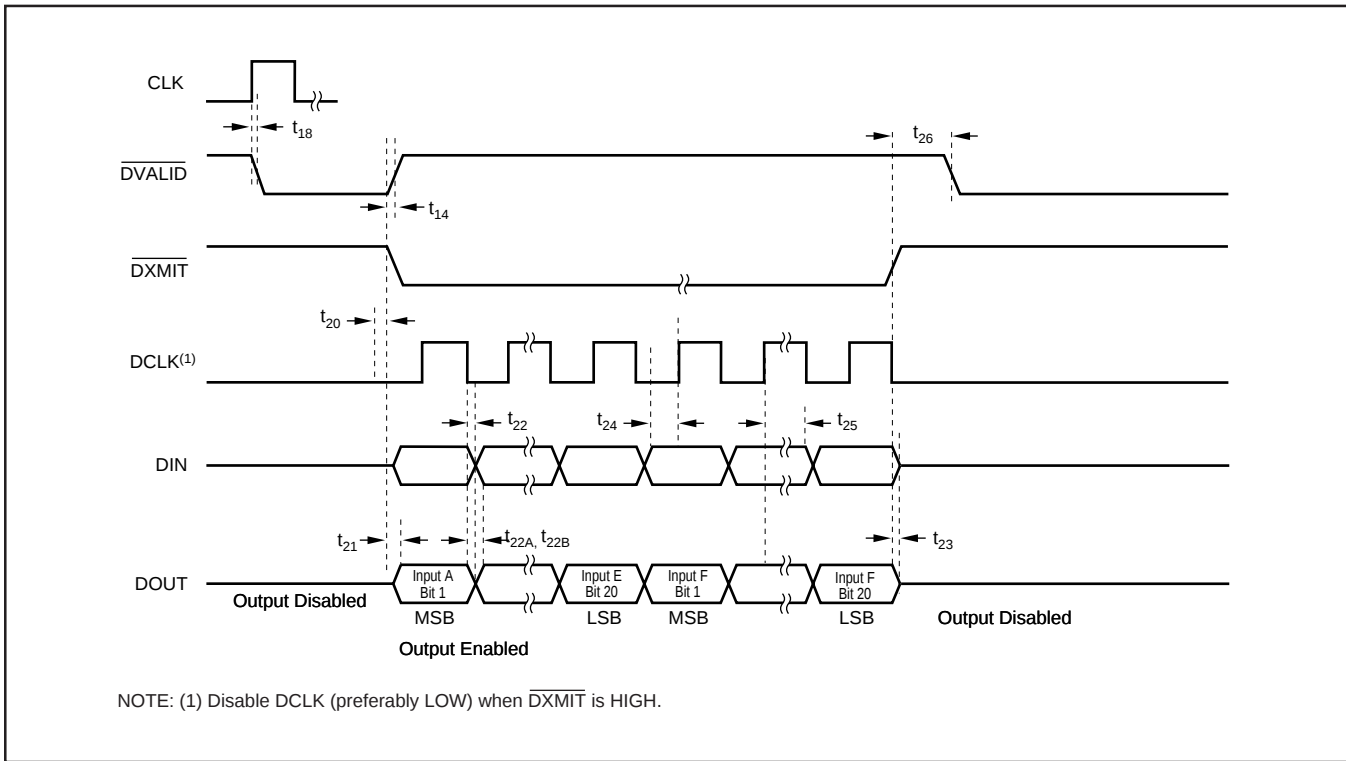


FIGURE 23. Timing Diagram When Using the DIN Function of the DDC112.

SYMBOL	DESCRIPTION	CLK = 10MHz			CLK = 15MHz			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
t_{24}	Set-Up Time From DIN to Rising Edge of DCLK	10			5			ns
t_{25}	Hold Time For DIN After Rising Edge of DCLK	10			10			ns
t_{26}	Hold Time for $\overline{DXMIT}$ HIGH Before Falling Edge of DVALID	2			1.33			μ s

TABLE X. Timing for the DDC112 Data Retrieval Using DIN.

RETRIEVAL BEFORE CONV TOGGLES (CONTINUOUS MODE)

This is the most straightforward method. Data retrieval begins soon after DVALID goes LO and finishes before CONV toggles, see Figure 24. For best performance, data retrieval must stop t_{28} before CONV toggles. This method is the most appropriate for longer integration times. The maximum time available for readback is $T_{INT} - t_{27} - t_{28}$. For DCLK and CLK = 10MHz, the maximum number of DDC112s that can be daisy-chained together is:

$$\frac{T_{INT} - 431.2\mu s}{40\tau_{DCLK}}$$

Where τ_{DCLK} is the period of the data clock. For example, if $T_{INT} = 100\mu s$ and DCLK = 10MHz, the maximum number of DDC112s is:

$$\frac{1000\mu s - 431.2\mu s}{(40)(100ns)} = 142.2 \rightarrow 142 \text{ DDC112s}$$

RETRIEVAL AFTER CONV TOGGLES (CONTINUOUS MODE)

For shorter integration times, more time is available if data retrieval begins after CONV toggles and ends before the new data is ready. Data retrieval must wait t_{29} after CONV toggles before beginning. Figure 25 shows an example of this. The maximum time available for retrieval is $t_{27} - t_{29} - t_{26}$ ($421.2\mu s - 10\mu s - 2\mu s$ for CLK = 10MHz), regardless of T_{INT} . The maximum number of DDC112s that can be daisy-chained together is:

$$\frac{409.2\mu s}{40\tau_{DCLK}}$$

For DCLK = 10MHz, the maximum number of DDC112s is 102.

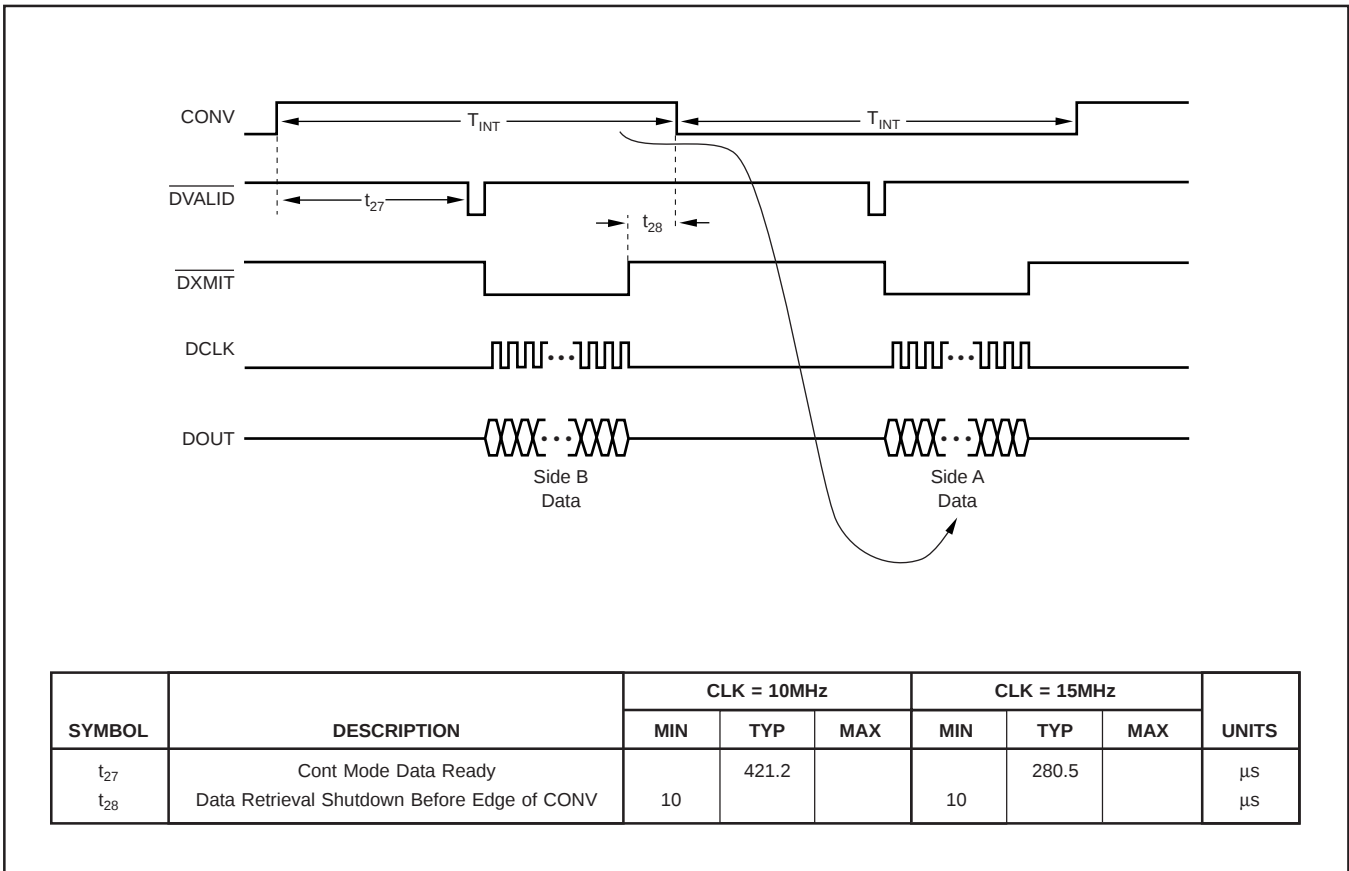


FIGURE 24. Readback *Before* CONV Toggles.

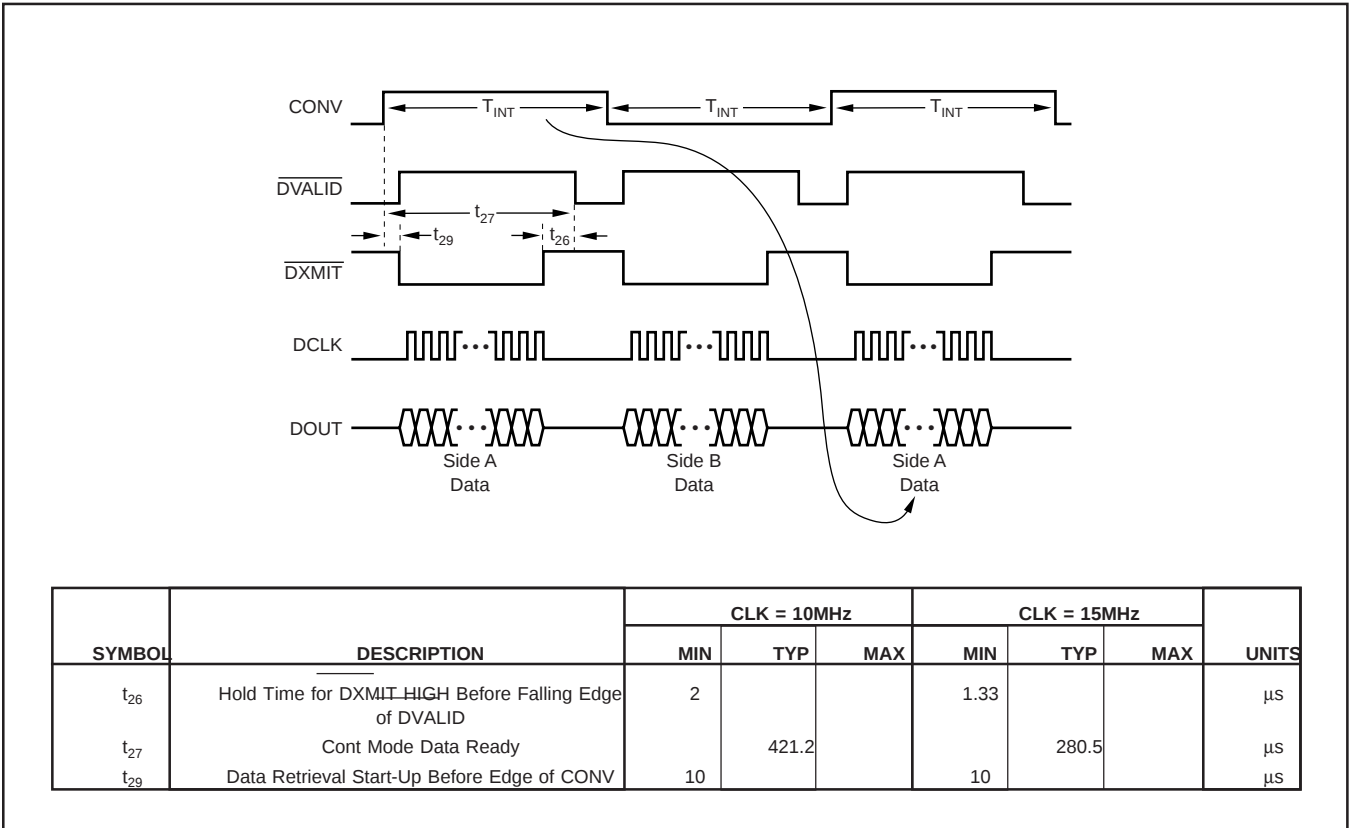


FIGURE 25. Readback *After* CONV Toggles.

RETRIEVAL *BEFORE AND AFTER* CONV
TOGGLES (CONTINUOUS MODE)

For the absolute maximum time for data retrieval, data can be retrieved *before and after* CONV toggles. Nearly all of T_{INT} is available for data retrieval. Figure 26 illustrates how this is done by combining the two previous methods. You must pause the retrieval during CONV's toggling to prevent digital noise, as discussed previously, and finish before the

next data is ready. The maximum number of DDC112s that can be daisy-chained together is:

$$\frac{T_{INT} - 20\mu s - 2\mu s}{40\tau_{DCLK}}$$

For $T_{INT} = 500\mu s$ and $DCLK = 10MHz$, the maximum number of DDC112s is 119.

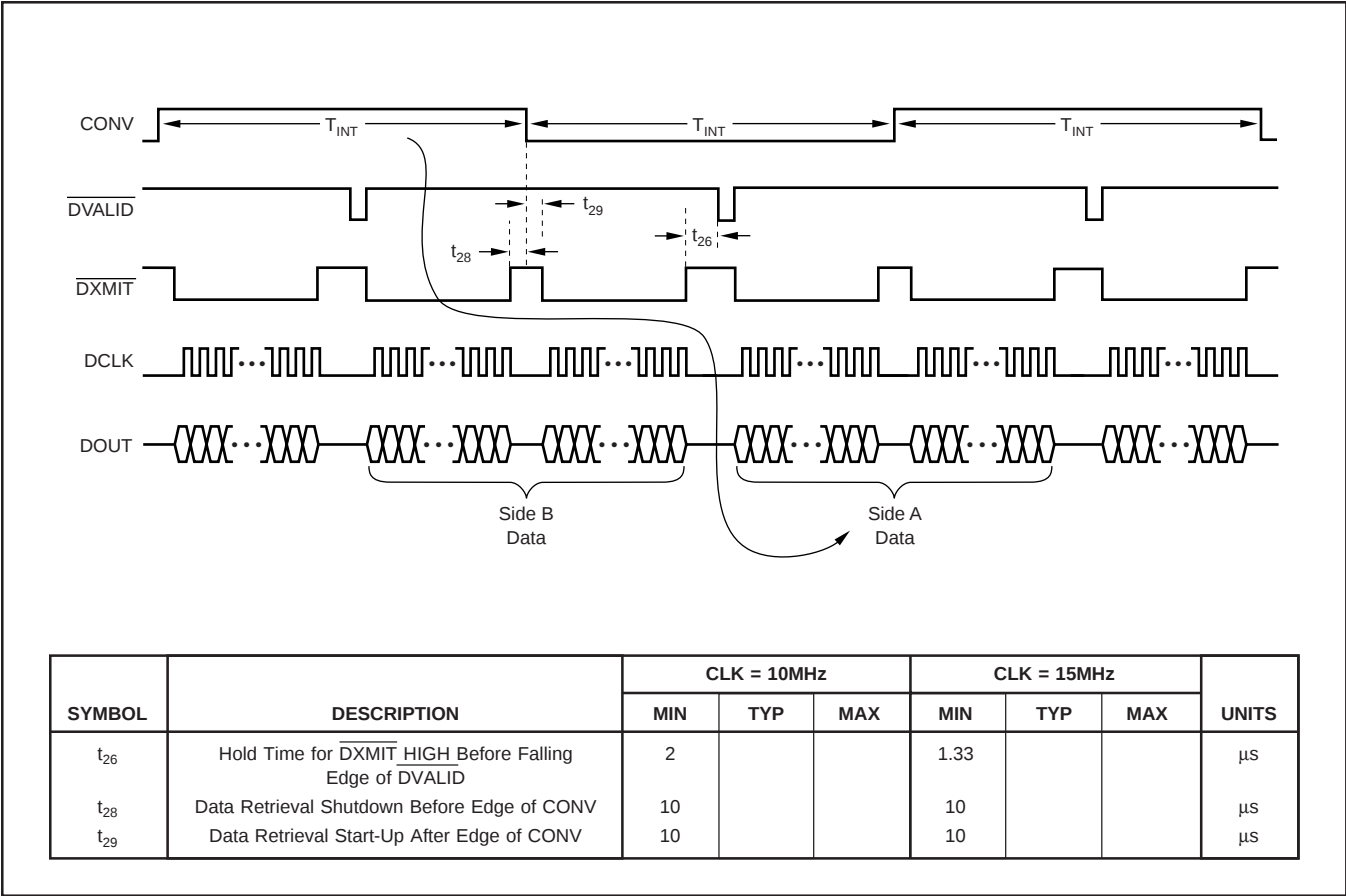


FIGURE 26. Readback *Before and After* CONV Toggles.

RETRIEVAL: NONCONTINUOUS MODE

Retrieving in noncontinuous mode is slightly different as compared with the continuous mode. As shown in Figure 27 and described in detail in Application Bulletin AB-131, $\overline{\text{DVALID}}$ goes LOW in time t_{30} after the first integration completes. If T_{INT} is shorter than this time, all of t_{31} is available to retrieve data before the other side's data is ready. For $T_{\text{INT}} > t_{30}$, the first integration's data is ready before the second integration completes. Data retrieval must be delayed until the second integration completes leaving less time available for retrieval. The time available is $t_{31} - (T_{\text{INT}} - t_{30})$. The second integration's data must be retrieved before the next round of integrations begin. This

time is highly dependent on the pattern used to generate CONV. As with the continuous mode, data retrieval must halt before and after CONV toggles (t_{28} , t_{29}) and be completed before new data is ready (t_{26}).

POWER-UP SEQUENCING

Prior to power-up, all digital and analog input pins must be LOW. At the time of power-up, these signal inputs can be biased to a voltage other than 0V, however, they should never exceed AV_{DD} or DV_{DD} . The level of CONV at power-up is used to determine which side (A or B) will be integrated first. Before integrations can begin though, CONV must toggle, as shown in Figure 28.

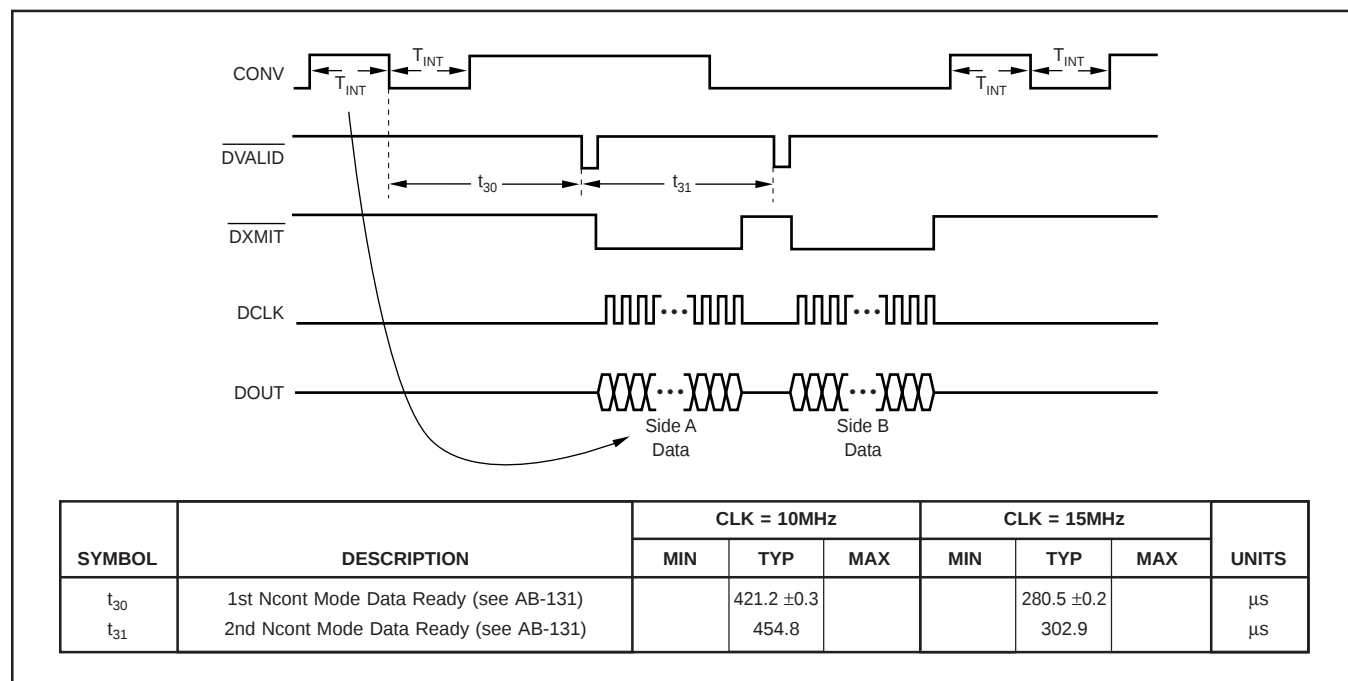


FIGURE 27. Readback in Noncontinuous Mode.

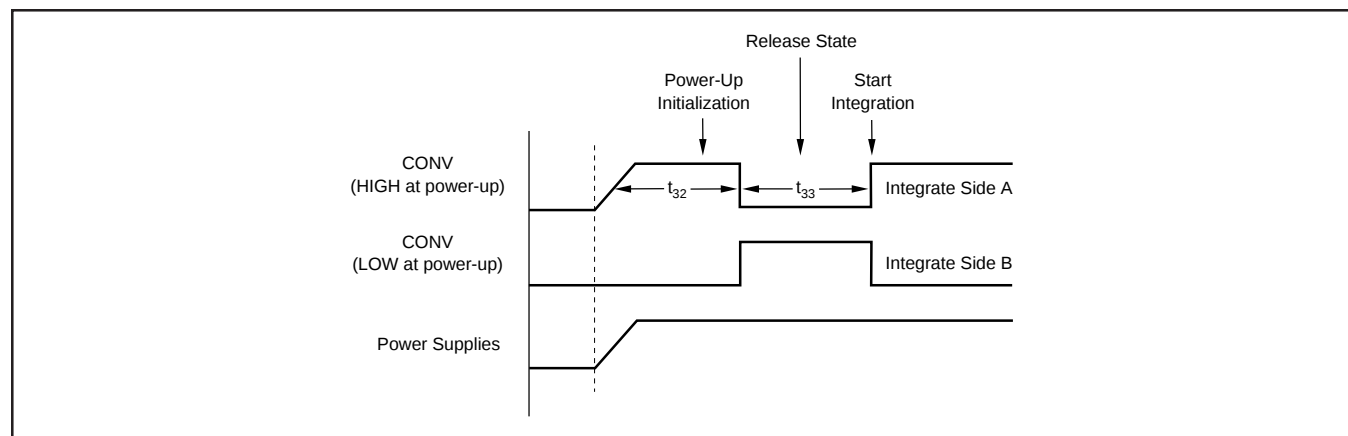


FIGURE 28. Timing Diagram at Power-Up of the DDC112.

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNITS
t_{32}	Power-On Initialization Period	50			μs
t_{33}	From Release Edge to Integration Start	50			μs

TABLE XI. Timing for the DDC112 Power-Up Sequence.

LAYOUT

Power Supplies and Grounding

Both AV_{DD} and DV_{DD} should be as quiet as possible. It is particularly important to eliminate noise from AV_{DD} that is non-synchronous with the DDC112 operation. Figure 29 illustrates two acceptable ways to supply power to the DDC112. The first case shows two separate +5V supplies for AV_{DD} and DV_{DD} . In this case, each +5V supply of the DDC112 should be bypassed with 10 μ F solid tantalum capacitors and 0.1 μ F ceramic capacitors. The second case shows the DV_{DD} power supply derived from the AV_{DD} supply with a < 10 Ω isolation resistor. In both cases, the 0.1 μ F capacitors should be placed as close to the DDC112 package as possible.

Shielding Analog Signal Paths

As with any precision circuit, careful printed circuit layout will ensure the best performance. It is essential to make short, direct interconnections and avoid stray wiring capacitance—particularly at the analog input pins. Digital signals

should be kept as far from the analog input signals as possible on the PC board.

Input shielding practices should be taken into consideration when designing the circuit layout for the DDC112. The inputs to the DDC112 are high impedance and extremely sensitive to extraneous noise. Leakage currents between the PCB traces can exceed the input bias current of the DDC112 if shielding is not implemented. Figure 30 illustrates an acceptable approach to this problem. A PC ground plane is placed around the inputs of the DDC112 (pins 1 and 28). This shield helps minimize coupled noise into the input pins. Additionally, the pins that are used for the external integration capacitors (pins 3, 4, 5, 6, 23, 24, 25 and 26) should be guarded by a ground plane when the external capacitors are used.

The approach above reduces leakage affects by surrounding these sensitive pins with a low impedance analog ground. Leakage currents from other portions of the circuit will flow harmlessly to the low impedance analog ground rather than into the analog input stage of the DDC112.

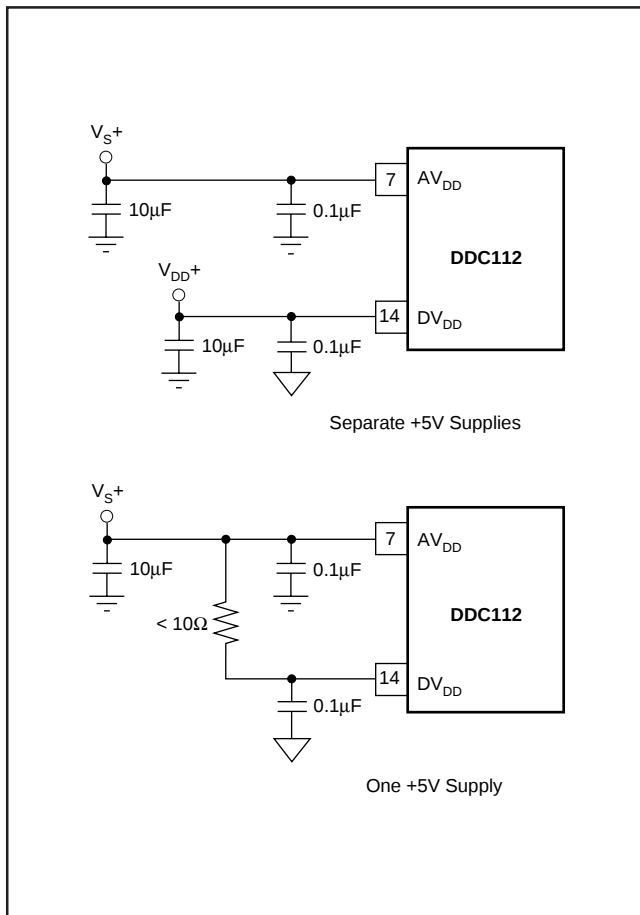


FIGURE 29. Power Supply Connection Options.

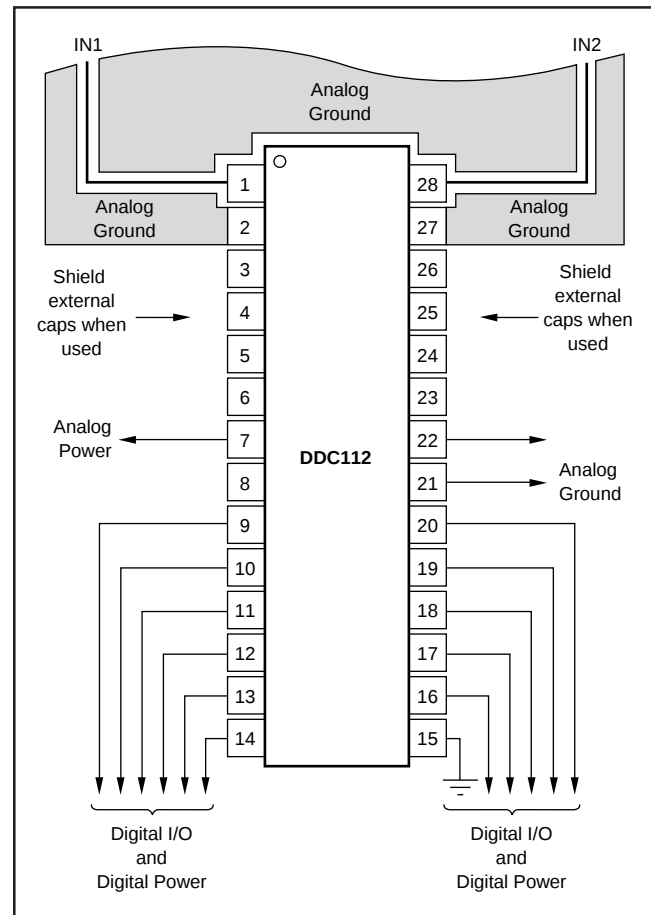


FIGURE 30. Recommended Shield for DDC112 Layout Design.